



*Universidad de Santiago de Chile
Dpto Ingeniería Mecánica*



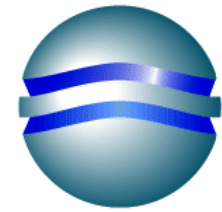
Macroscopic and local thermal characterization from infrared images processing : Analytical modeling and field estimation

Olivier Fudym

October 10-12, 2006, Mar del Plata

*PROJETO DE COOPERAÇÃO SUL-AMERICANA EM
IDENTIFICAÇÃO DE PROPRIEDADES FÍSICAS EM
TRANSFERÊNCIA DE CALOR E MASSA
Programa CNPq/PROSUL*

*Escola Sul-Americana em Identificação de
Propriedades Físicas em Transferência de
Calor e Massa – PROPFIS*



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C A R M A U X

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=

**Chemical Engineering Laboratory
for Finely Divided Solids,
Energy & Environment**

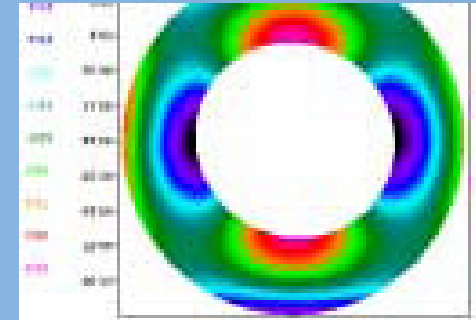
- South West of France
- Ministère de l'Economie, des Finances, et de l'Industrie
- Civil Engineers (*Major in Chemical Engineering*)



Background : New needs for full fields methods...

Spectacular Recent Progress

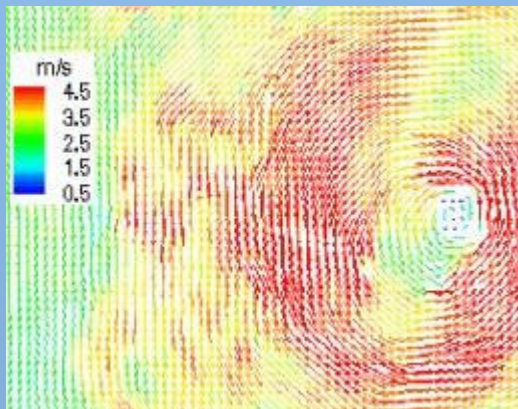
in field measurements...



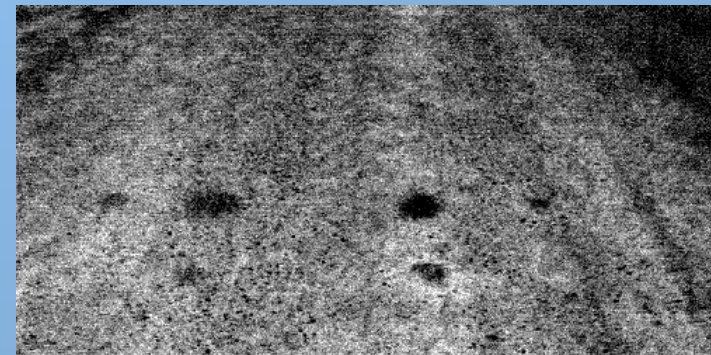
Vibrations Brake disks

Dr. Ettemeyer GmbH & Co, Germany

...Velocity, concentration, déformations, stress, temperature, density...



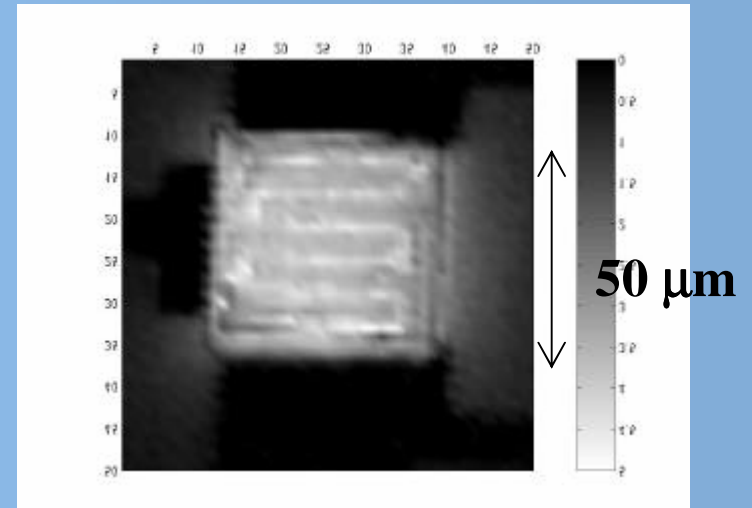
Particule Image Velocimetry(PIV)



**Underground Landmines Detection
from Thermal Imaging**

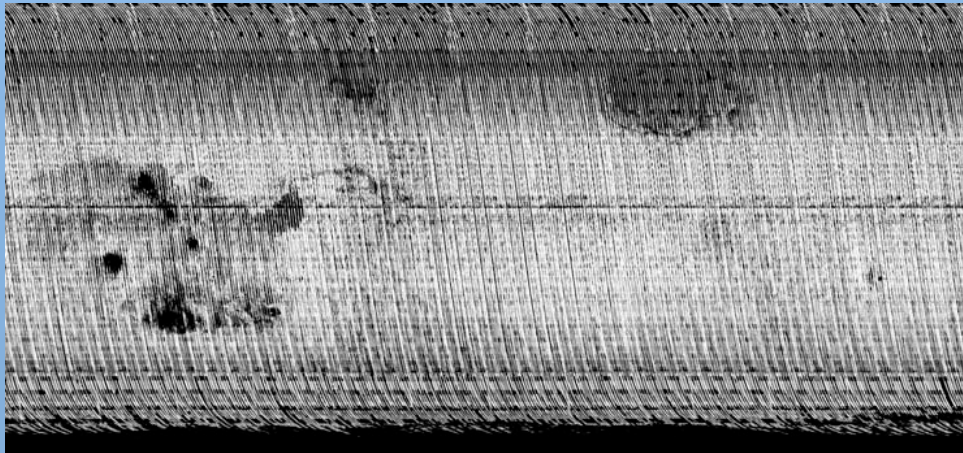
Background...

...From microscopic scale...



Temperature mapping of a micro heater
From photoreflectance imaging

...to astrophysic scale !



Mars Global Surveyor Thermal Emission Spectrometer
Thermal inertia mapping of Mars ground

...Background...

That is the « Full field methods » revolution...

Images are recorded from either :

1. One sensor scanning

Atomic force Microscopy, SThM, photoreflectance imaging, old fashion IR...

2. From a very high number of spatially distributed sensors

Focal Plane Array camera, PIV, Tomography X...

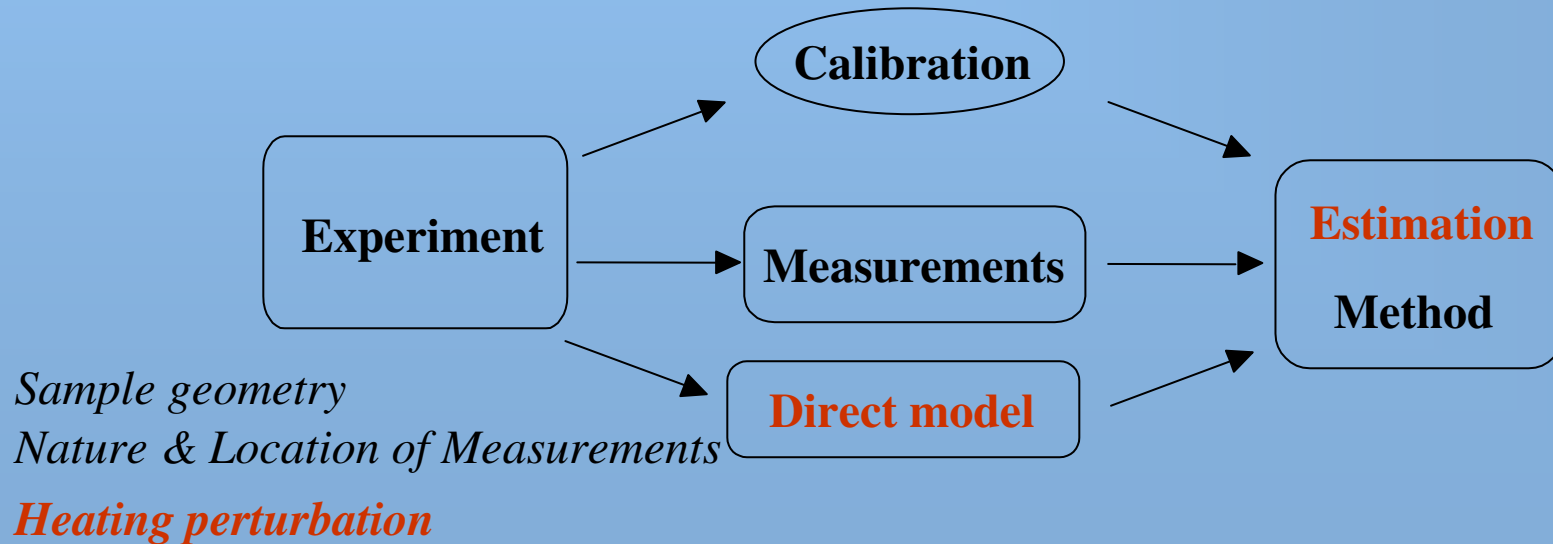
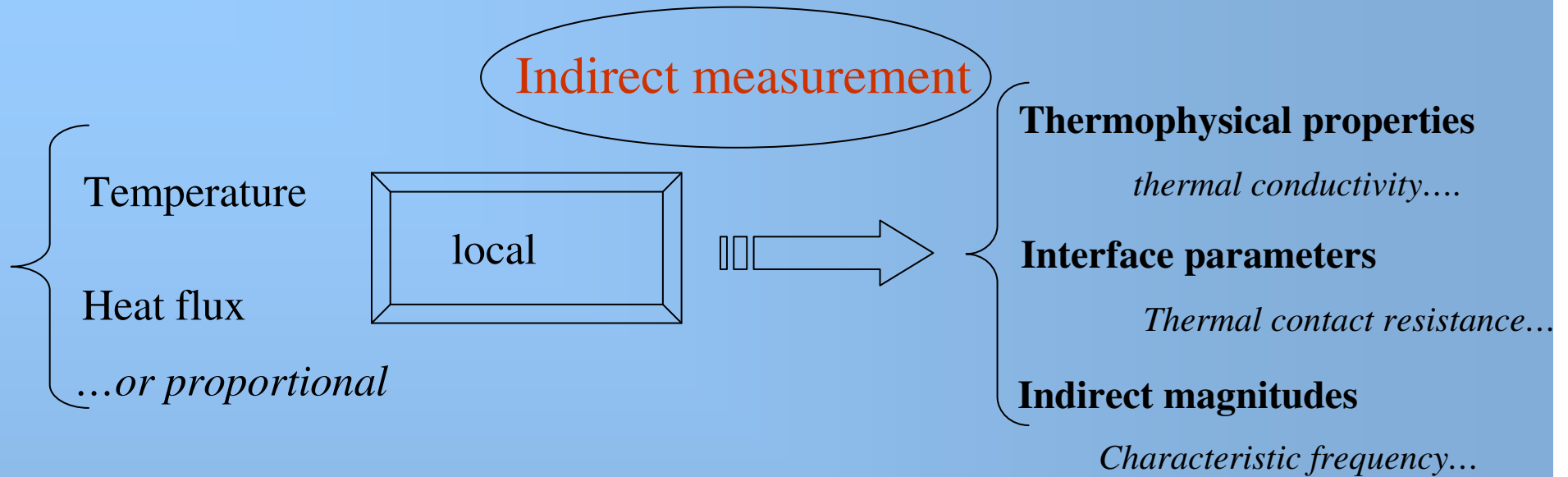
Challenge : how to process this intensive flux of data ?

Ex. : IR Camera 256 x 256 pixels 140 Hz 8 bits



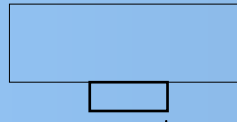
8.75 MB/s

Heat transfer parameters estimation



Our specific problem.....

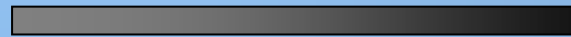
Thermal Surface Measurements



Thermal Excitation



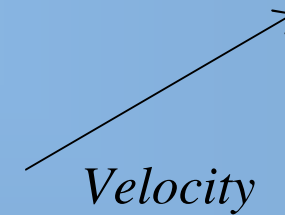
Thin medium



Thick medium



Behind a wall

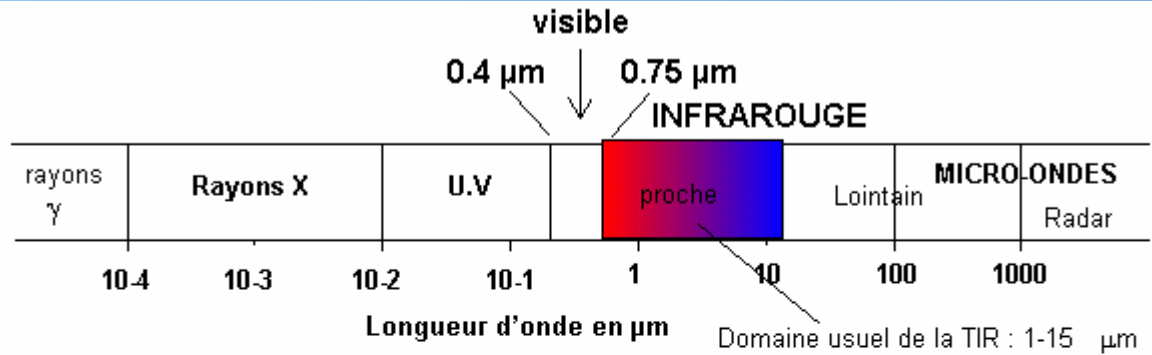


**Macroscopic and local thermal characterization
from infrared images processing :
Analytical modeling and field estimation**

1. Introduction to infrared thermography
2. The Thermal Quadrupole Formalism
3. Field Estimation for Local Mapping
4. Macroscopic characterization from averaging
5. Conclusion

1. Introduction to infrared thermography

Thermal Radiation



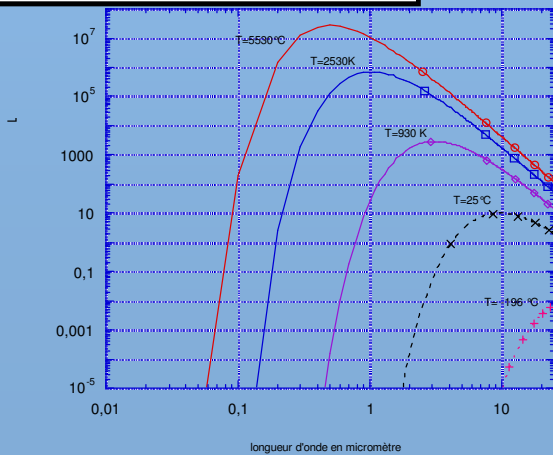
← sens des énergies (et des fréquences) croissantes

1 μm = 1 micromètre = 0.000001m

spectre visible : 0.4 μm = violet -bleu
0.47 μm = bleu
0.55 μm = vert-jaune
0.65 μm = rouge..

- Luminance spectrale (soleil)
- Luminance spectrale (lampe)
- ◇— Luminance spectrale (température fusion -aluminium)
- - - x - - - Luminance spectrale (ambiant)
- - - + - - - Luminance spectrale (azote liquide)

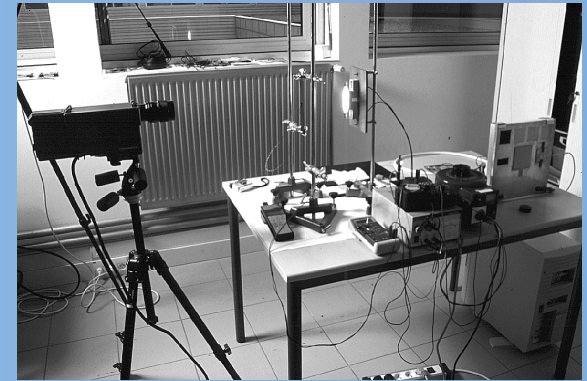
Luminance corps noir



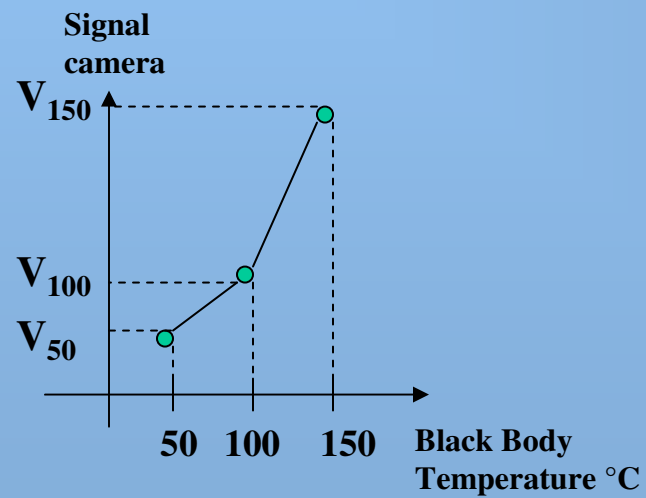
Infrared thermography : usually 1 – 15 μm

→ Energy
Sensitivity

Calibration : Black body



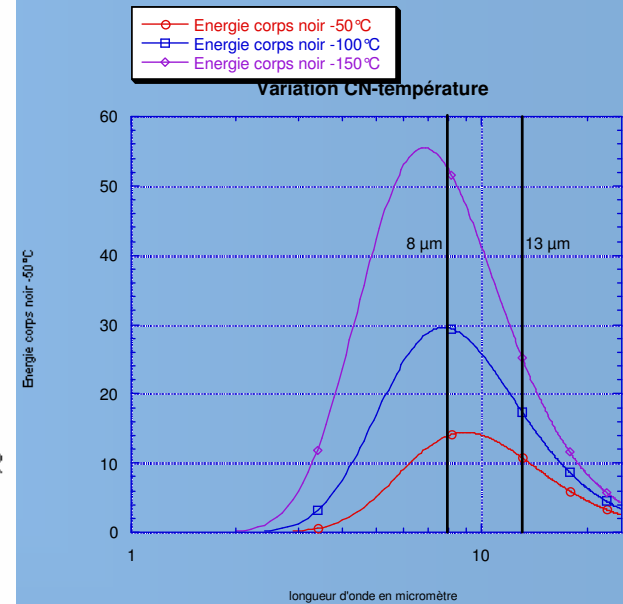
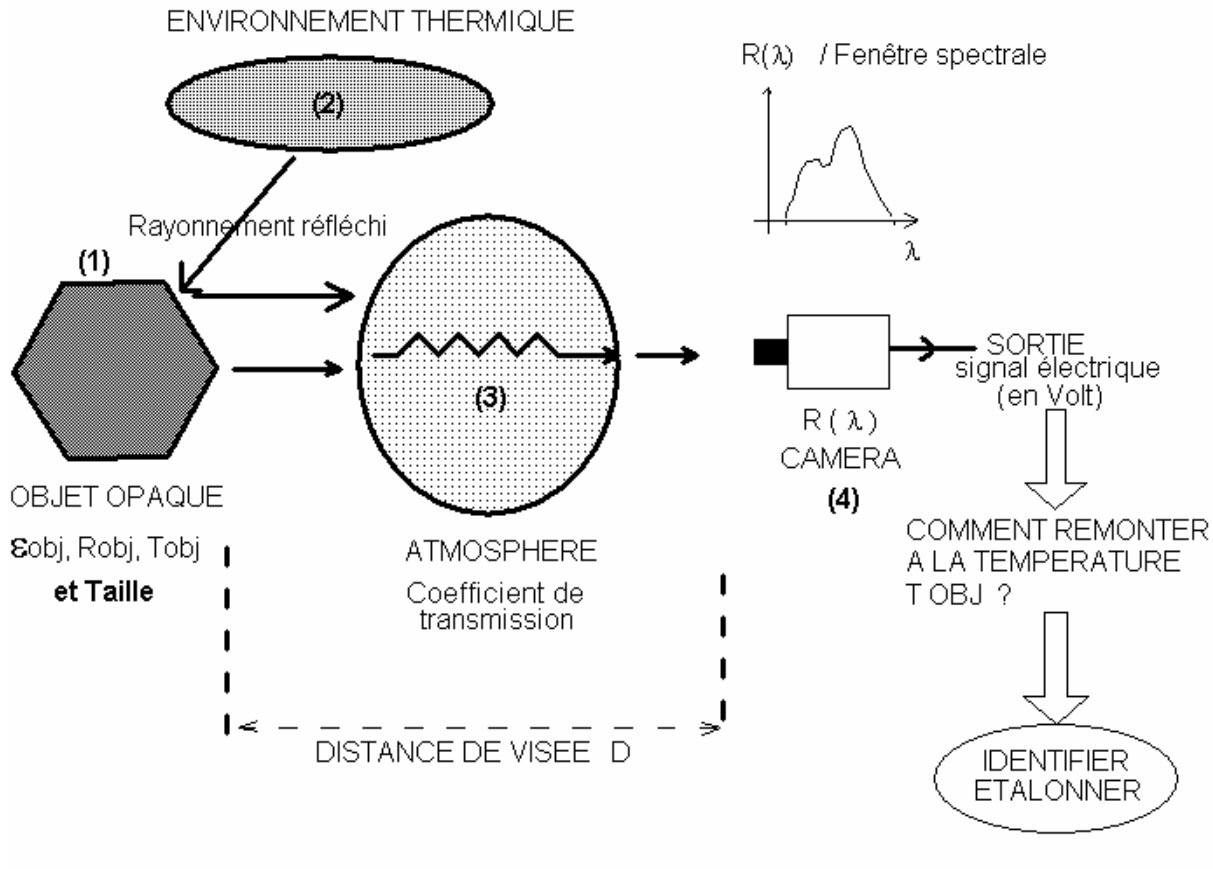
After calibration, the optical properties are necessary in order to measure the surface temperature of the sample :



Emissivity

$$\varepsilon = \frac{E_{\text{objet}}(T)}{E_{\text{Corps noir}}(T)}$$

Infrared measurement : typical situation



☑ Sensor : InSb, InGaAs, QWIP, microbolometric...

☑ Focal plane Array: 640x512 pixels or 320x256 pixels

☑ Typical : 150 – 400 Hz !!!

☑ thermal sensibility : 20 mK InSb, < 35 mK QWIP

☑ Spectral Sens. : 1 - 5 μm or 3 - 5 μm (InSb), 8,2 - 9,2 μm (QWIP)

☑ Integration time: about 10 μs

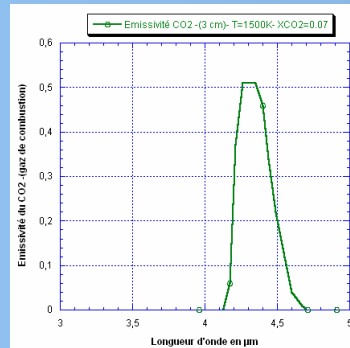
☑ Pitch : 30 μm



Combustion

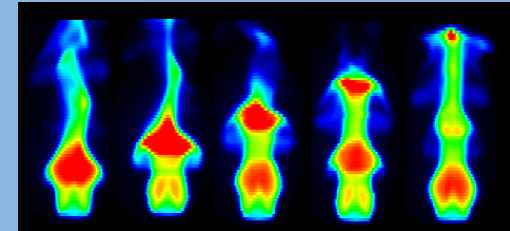


Methane - Air



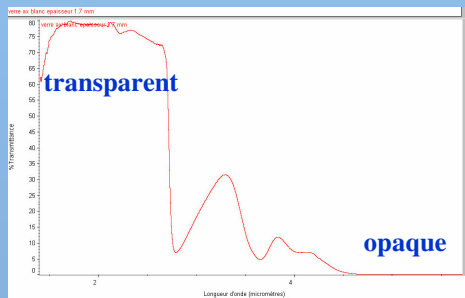
CO₂ spectral emissivity

3-5 µm



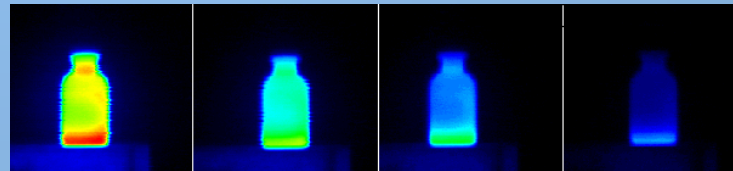
Flame instability

Glass bottle process

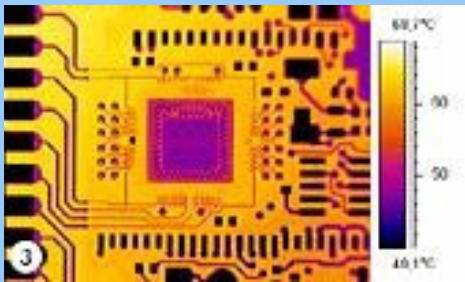


« Spectre » de transmission IR du verre

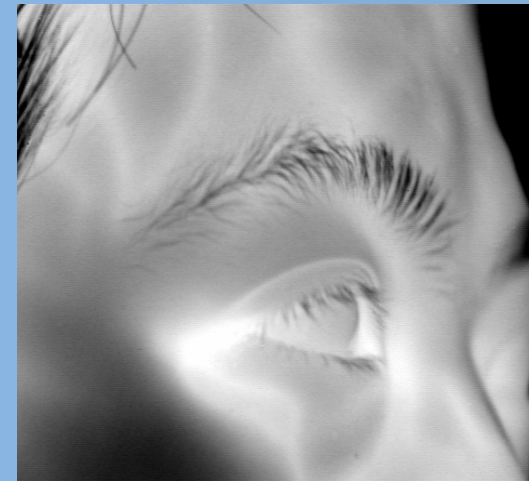
8 - 12 µm



Bottle Cooling / Surface Temperature



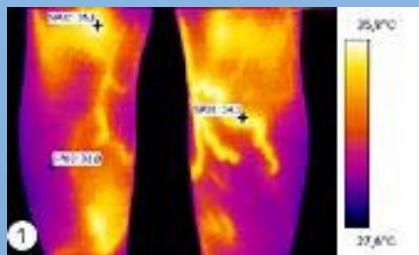
Microcomponent analysis



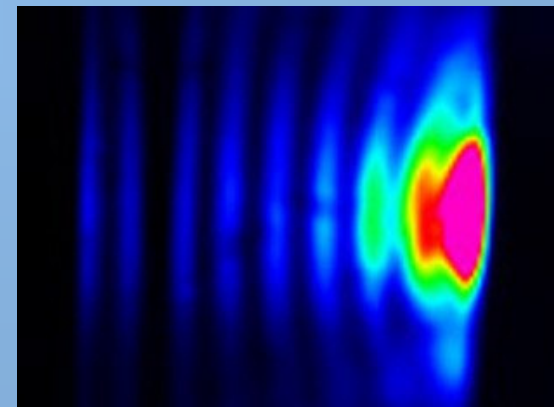
Skin & Fever



Art restoration



Vascular



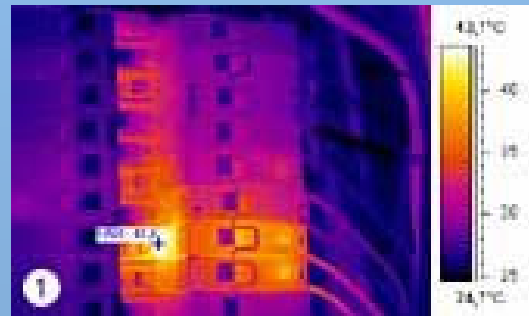
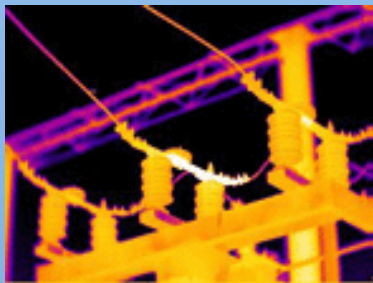
Microwave heating



Multispectral imagery



Aircraft signature



Electrical control



Security control

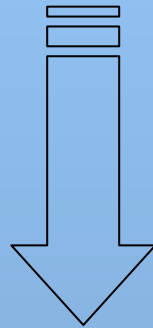
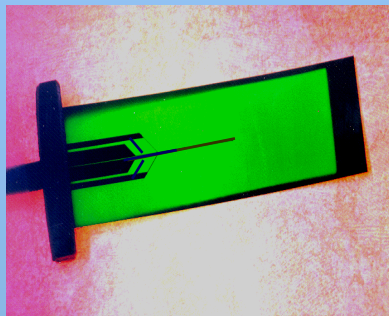
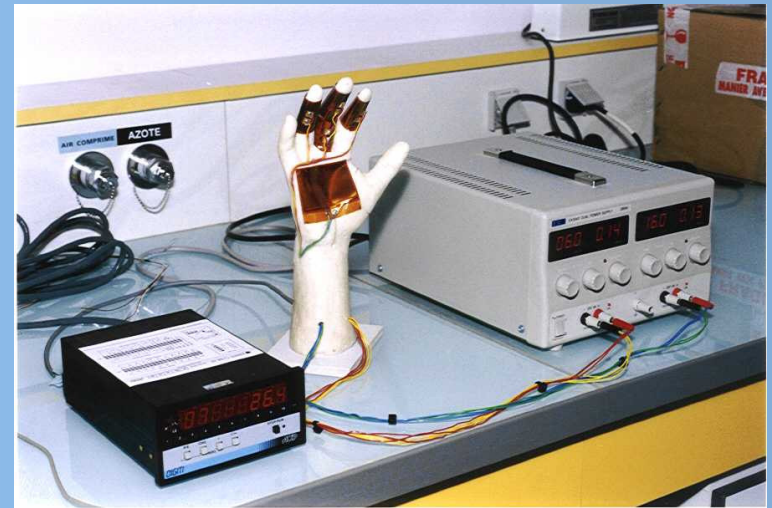
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2. The Thermal Quadrupole Formalism

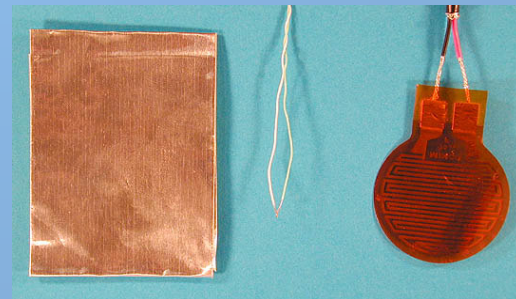
Motivation

Many Thermal Engineering problems do not require the knowledge of temperature and heat flux in the whole domain



Looking for analytical relationships between temperature and heat flux at some given locations

Heat transfer parameters measurement

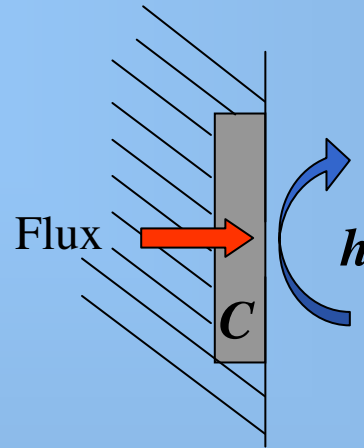


Pseudo-random heating

Convective coefficients mapping

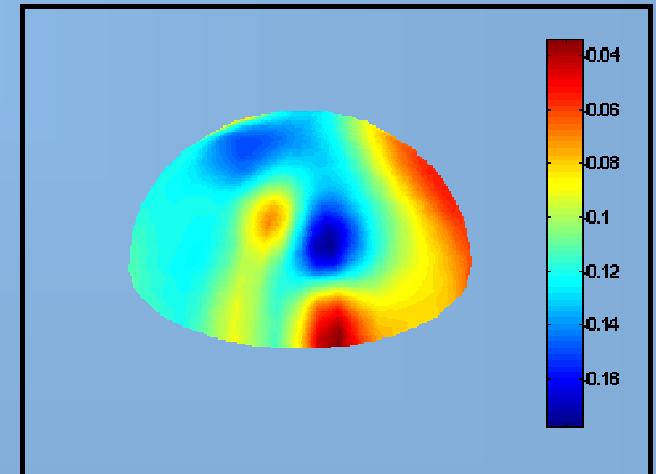
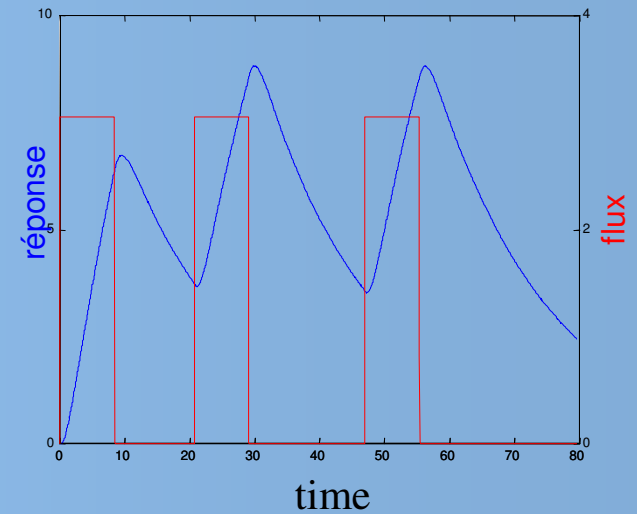


Thermal characterization of cyclist casque



$$C \frac{dT}{dt} = \varphi(t) - hT$$

Characteristic frequencies are estimated : $\frac{h}{C}$



2. The Thermal Quadrupole Formalism

Carslaw & Jaeger	1959	<i>Laplace space, quadrupole network</i>
A. Degiovanni et al.	1988	<i>LEMETA, Nancy, France</i>
J.C. Batsale et al.	1994	<i>2D, 3D...Integral transforms</i>
D. Maillet et al.	2000	<i>Thermal Quadrupole Book</i>

A. Degiovanni

*Conduction dans un «mur » multicouche avec sources : extension de la notion de quadripôle,
Int.J.Heat.Mass.Transfer. Vol 3, 553 - 557, 1988*

D. Maillet, S. André, J.C. Batsale, A. Degiovanni, C. Moyne

*Thermal quadrupoles : Solving the heat equation through integral transforms
Wiley, London, 2000*

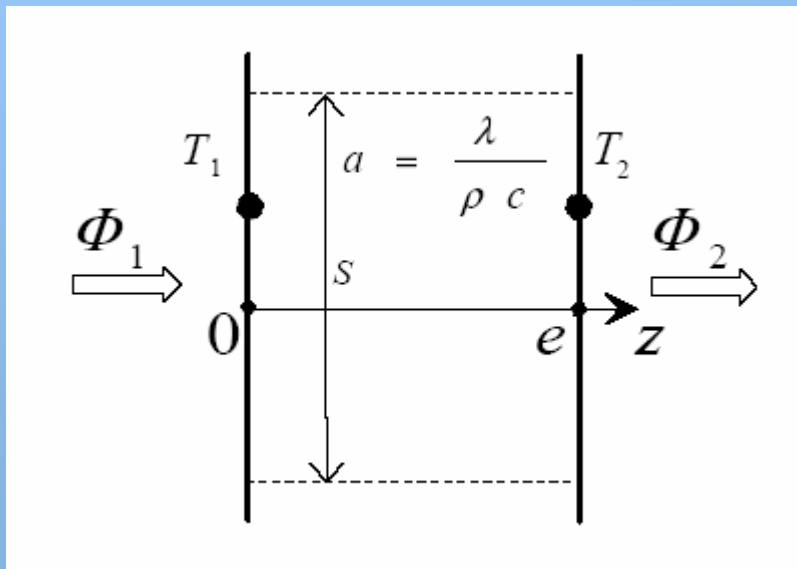
Thermal Quadrupole Formalism

$$\frac{1}{a} \frac{\partial T}{\partial t} = \frac{\partial^2 T}{\partial z^2} \quad \text{with} \quad T(z)=0 \text{ for } t=0 \quad \Rightarrow$$

Laplace Transform

$$\frac{d^2 \theta}{dz^2} - \frac{s}{a} \theta = 0$$

$$K = \sqrt{\frac{s}{a}}$$



$$\theta(z, s) = G_1 \cosh(Kz) + G_2 \sinh(Kz)$$

$$\phi(z, s) = -kS \frac{d\theta}{dz}$$

$$\phi(z, s) = -kSK(G_1 \sinh(Kz) + G_2 \cosh(Kz))$$

Substitute the input/output boundary conditions : $T_1 ; \Phi_1$ and $T_2 ; \Phi_2$

...in order to eliminate the coefficients G_1 and G_2

Thermal Quadrupole Formalism

$$\begin{bmatrix} \theta_e(s) \\ \Phi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \Phi_s(s) \end{bmatrix}$$

$$\begin{bmatrix} A = \cosh(Ke) & B = \frac{\sinh(Ke)}{kKS} \\ C = kKS \sinh(Ke) & D = \cosh(Ke) \end{bmatrix}$$

OR

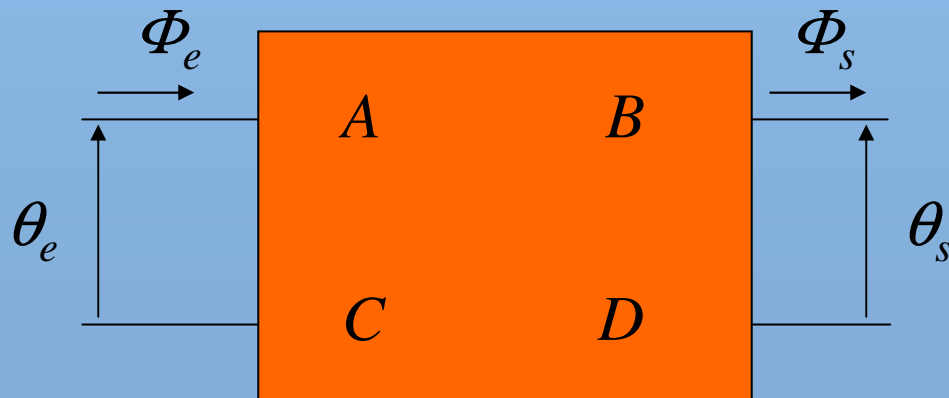
$$\begin{bmatrix} \theta_e(s) \\ \varphi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \varphi_s(s) \end{bmatrix}$$

$$\begin{bmatrix} A = \cosh(Ke) & B = \frac{\sinh(Ke)}{kK} \\ C = kK \sinh(Ke) & D = \cosh(Ke) \end{bmatrix}$$

thermal conductivity

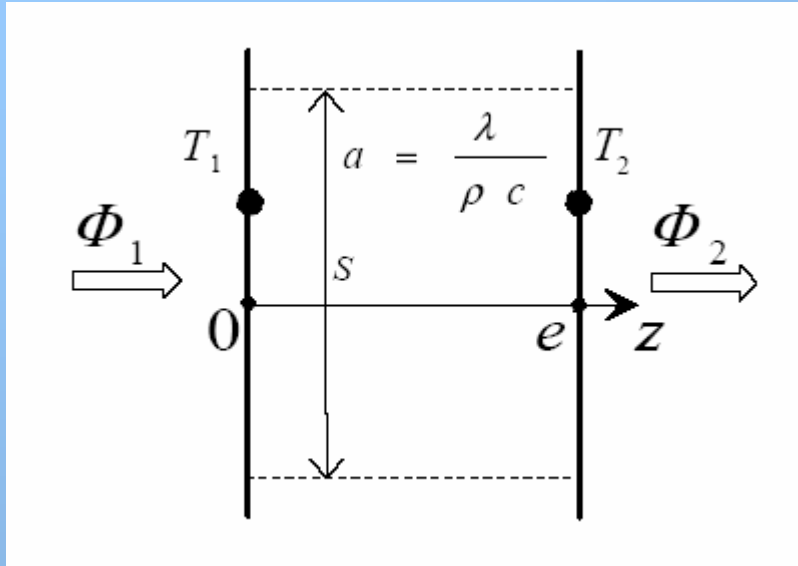
thermal diffusivity

Thickness



**Intrinsic
linear relationship
between
input / output variables**

Thermal Quadrupole Formalism



$$\begin{bmatrix} \theta_e(s) \\ \Phi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \Phi_s(s) \end{bmatrix}$$

Well-posed problem



Two boundary conditions are known



Two remaining equations given by the quadrupole

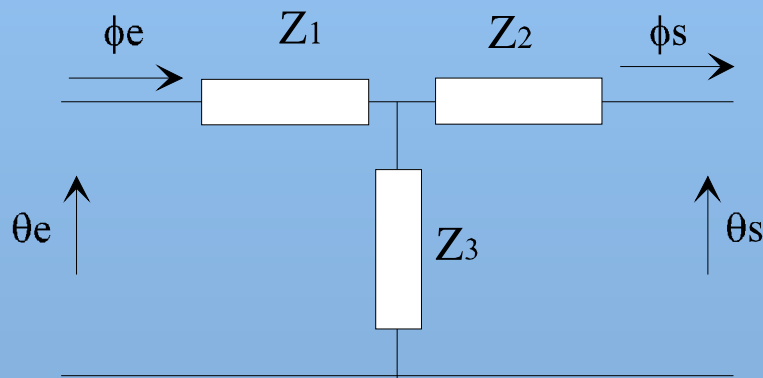
Thermal Quadrupole Formalism

$$\begin{bmatrix} \theta_e(s) \\ \Phi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \Phi_s(s) \end{bmatrix}$$

$$AD - BC = 1$$

$$A = D$$

(Symmetrical system)

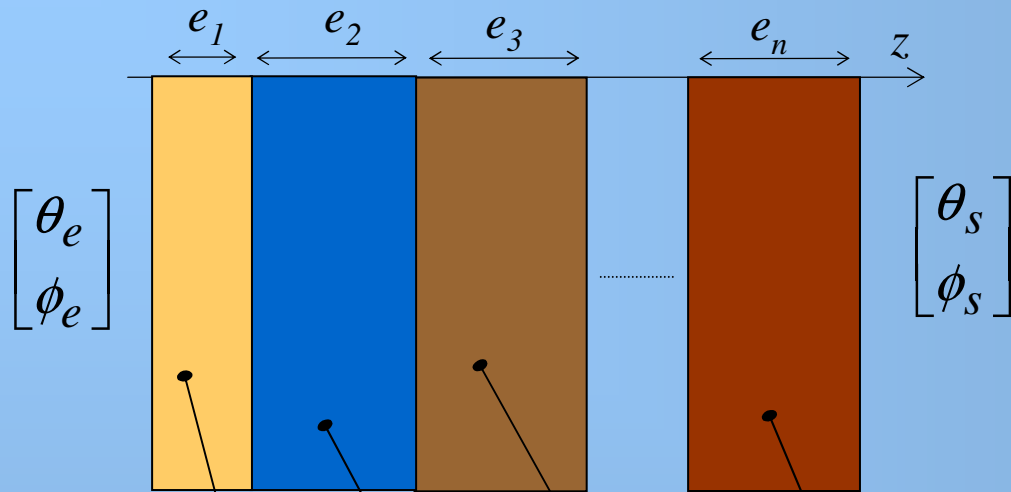


$$Z_1 = \frac{A-1}{C} \quad Z_2 = \frac{D-1}{C} \quad Z_3 = \frac{1}{C}$$

$$\frac{at}{e^2} \gg 1 \quad \Rightarrow \quad s \rightarrow 0$$

$$\begin{cases} Z_1 = Z_2 \rightarrow \frac{e}{2kS} \\ Z_3 \rightarrow \frac{1}{\rho c_p e S p} \end{cases}$$

Multilayer System



$$\begin{bmatrix} \theta_e \\ \phi_e \end{bmatrix} = \begin{bmatrix} AB \\ CD \end{bmatrix} \begin{bmatrix} \theta_s \\ \phi_s \end{bmatrix}$$

$$\begin{bmatrix} AB \\ CD \end{bmatrix} = \begin{bmatrix} A_1 B_1 \\ C_1 D_1 \end{bmatrix} \begin{bmatrix} A_2 B_2 \\ C_2 D_2 \end{bmatrix} \begin{bmatrix} A_3 B_3 \\ C_3 D_3 \end{bmatrix} \cdots \begin{bmatrix} A_n B_n \\ C_n D_n \end{bmatrix}$$

...As well as the interface vectors :

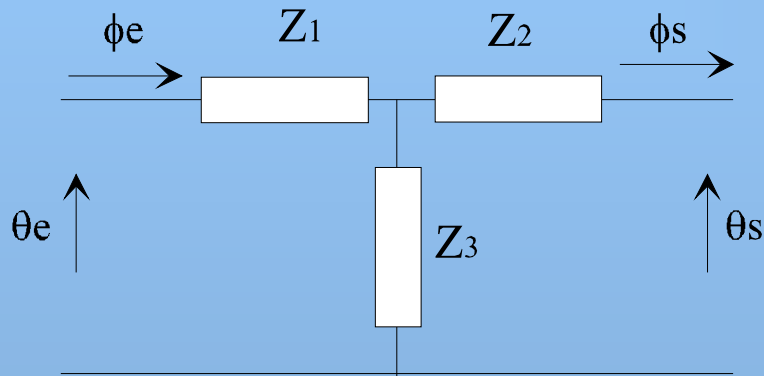
$$\begin{bmatrix} \theta_i \\ \phi_i \end{bmatrix} = \begin{bmatrix} A_i & B_i \\ C_i & D_i \end{bmatrix} \cdots \begin{bmatrix} A_n & B_n \\ C_n & D_n \end{bmatrix} \begin{bmatrix} \theta_s \\ \phi_s \end{bmatrix}$$

Semi-infinite medium

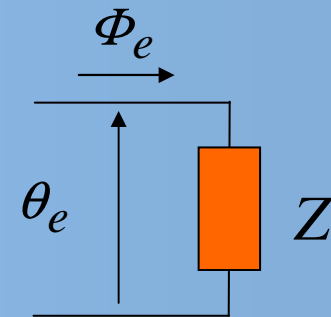
$$\begin{bmatrix} \theta_e(s) \\ \Phi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \Phi_s(s) \end{bmatrix}$$

$$\xrightarrow{e \rightarrow \infty}$$

$$\theta_e = Z \Phi_e$$



$$\begin{cases} Z_1 \rightarrow Z/2 \\ Z_2 \rightarrow Z/2 \\ Z_3 \rightarrow 0 \end{cases}$$



$$Z = \frac{1}{S \sqrt{k \rho c \sqrt{s}}}$$

Interface conditions

Thermal contact resistance

$$T_1 - T_2 = R_c \phi$$

$$\begin{bmatrix} \theta_1 \\ \Phi_1 \end{bmatrix} = \begin{bmatrix} 1 & R_c \\ 0 & 1 \end{bmatrix} \begin{bmatrix} \theta_2 \\ \Phi_2 \end{bmatrix}$$

Newton B.C.

$$\phi = hS(T_1 - T_\infty)$$

$$\begin{bmatrix} \theta_1 \\ \Phi_1 \end{bmatrix} = \begin{bmatrix} 1 & \frac{1}{hS} \\ 0 & 1 \end{bmatrix} \begin{bmatrix} \theta_\infty \\ \Phi_\infty \end{bmatrix}$$

Heat Capacity condition

$$C \frac{dT}{dt} = \phi_1 - \phi_2$$

$$\begin{bmatrix} \theta_1 \\ \Phi_1 \end{bmatrix} = \begin{bmatrix} 1 & 0 \\ C_s & 1 \end{bmatrix} \begin{bmatrix} \theta_2 \\ \Phi_2 \end{bmatrix}$$

Internal heat sources and initial temperature imbalance

$$\frac{1}{a} \frac{\partial T}{\partial t} = \frac{\partial^2 T}{\partial z^2} + \frac{g(z,t)}{k} \quad \text{with} \quad T(z) = T_0(z) \quad \text{for} \quad t=0$$



$$\frac{d^2 \theta}{dz^2} + \frac{G(z,s)}{k} + \frac{T_0(z)}{a} - \frac{s}{a} \theta = 0$$

$$\theta(z,s) = G_1 \cosh(Kz) + G_2 \sinh(Kz) + \theta_{part}$$

$$\begin{bmatrix} \theta_e(s) \\ \Phi_e(s) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_s(s) \\ \Phi_s(s) \end{bmatrix} - \begin{bmatrix} X \\ Y \end{bmatrix}$$

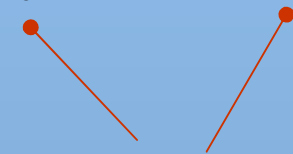
Cylindrical coordinate system

$$\frac{1}{a} \frac{\partial T}{\partial t} = \frac{1}{r} \frac{\partial}{\partial r} \left(r \frac{\partial T}{\partial r} \right)$$



$$\frac{d^2 \theta}{dr^2} + \frac{1}{r} \frac{d\theta}{dr} - \frac{s}{a} \theta = 0$$

$$\theta(z, s) = G_1 I_0(Kr) + G_2 K_0(Kr)$$



Bessel functions

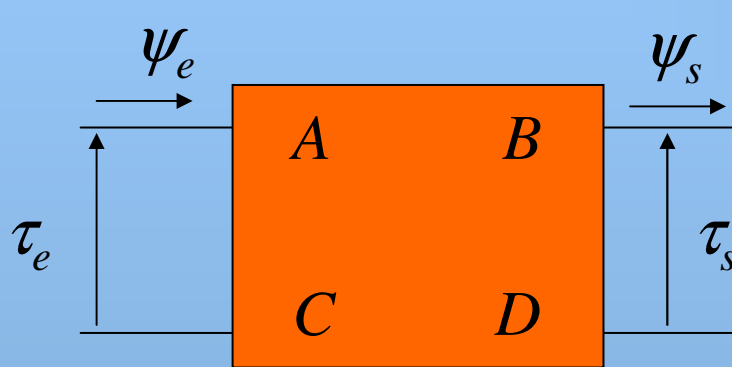
$$\phi = -kS \frac{d\theta}{dr} \quad \text{with} \quad S = 2\pi rL$$

Two or three dimensional cases

$$\frac{1}{a} \frac{\partial T}{\partial t} = \frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial z^2} \quad \Longrightarrow \quad \tau(\beta_n, z, s) = \int_0^\infty \int_0^L T(x, z, t) \exp(-st) \cos(\beta_n x) dx dt$$

Laplace-Fourier Transform

$\beta_n =$ Eigenvalues from boundary-value problem relative to x



$$\frac{d^2 \tau}{dx^2} - K \tau = 0$$

Generalized frequency

$$K = \sqrt{\beta_n^2 + \frac{s}{a}}$$

$$\begin{bmatrix} \tau_e(s) \\ \psi_e(s) \end{bmatrix} = \begin{bmatrix} A(\beta_n, s) & B(\beta_n, s) \\ C(\beta_n, s) & D(\beta_n, s) \end{bmatrix} \begin{bmatrix} \tau_s(s) \\ \psi_s(s) \end{bmatrix}$$

J.C Batsale, D. Maillet, A. Degiovanni

Extension de la notion de quadripôle thermique à l'aide de transformations intégrales :

calcul du transfert thermique au travers d'un défaut plan bidimensionnel,

Int.J.Heat.Mass.Transfer. Vol 37, 111 - 127, 1994

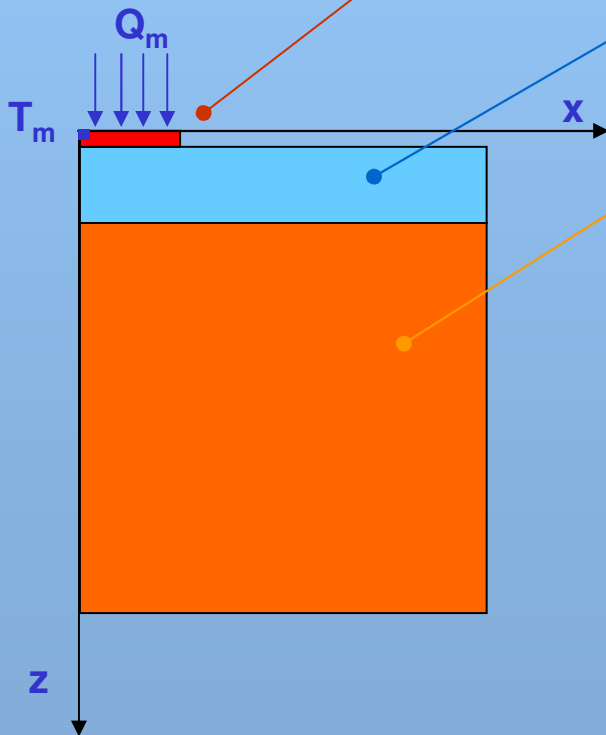
Multilayer example : super insulating materials characterization

$$\begin{bmatrix} \tau_m(\beta_n, s) \\ \varphi_m(\beta_n, s) \end{bmatrix} =$$

$$\begin{bmatrix} 1 & 0 \\ (\rho c_p)_s e_s s & 1 \end{bmatrix}$$

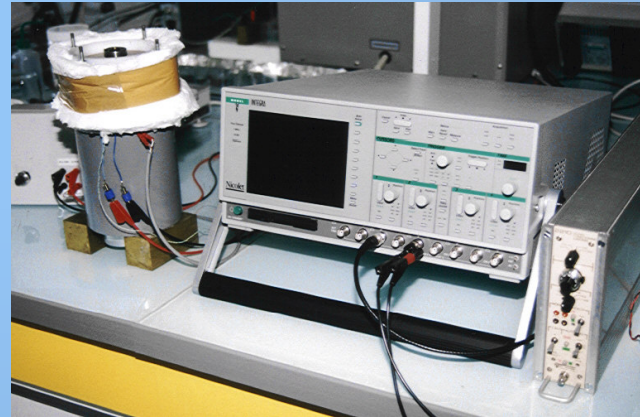
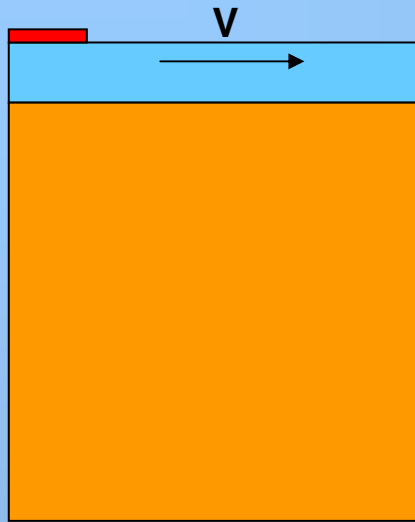
$$\begin{bmatrix} A & B \\ C & D \end{bmatrix}$$

$$\begin{bmatrix} \tau(\beta_n, e_s + e, s) \\ \lambda_2 \sqrt{\frac{p}{a_2} + \alpha_n^2} \tau(\beta_n, e_s + e, s) \end{bmatrix}$$



Monolithic silica aerogel

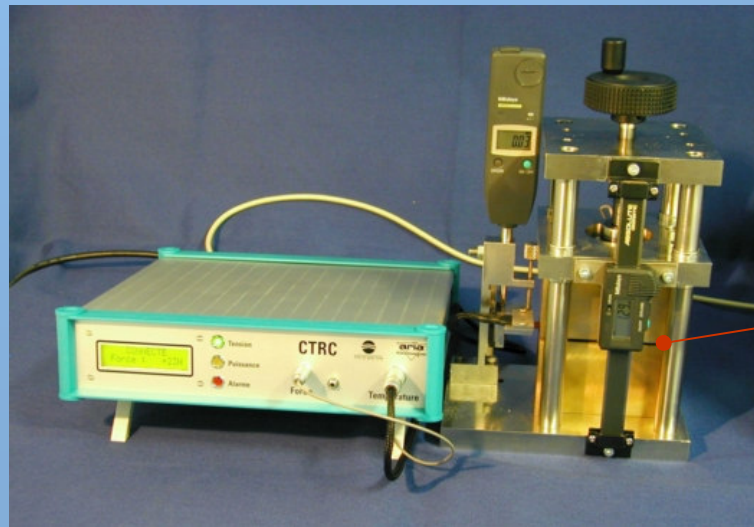
Extension for thermal characterization of liquids in Couette flow



Thermal conductivity

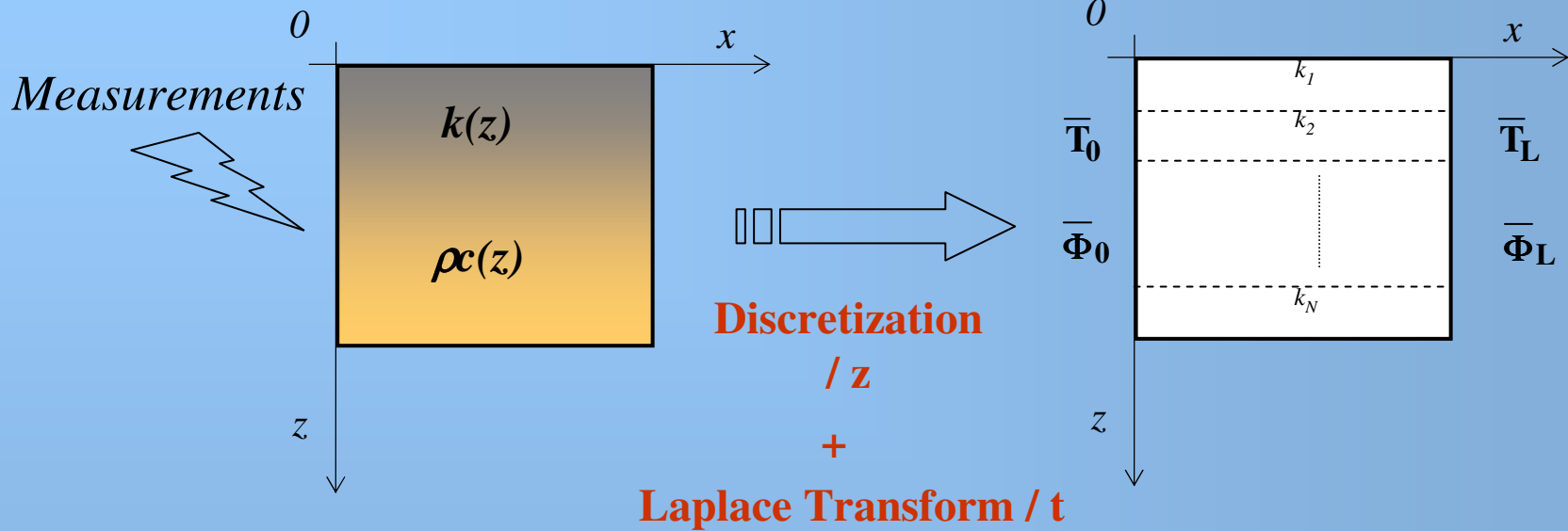
Viscosity

Transfer of technology :
« Capthermic » start-up



Compressible material

Semi-analytical extension for heterogeneous media



$$k(z) \frac{\partial^2 T}{\partial x^2} + \frac{\partial}{\partial z} \left(k(z) \frac{\partial T}{\partial z} \right) = (\rho c)(z) \frac{\partial T}{\partial t} \quad \Rightarrow \quad \mathbf{M}_s (\mathbf{M}_{//} + \mathbf{G}_s) \bar{\mathbf{T}} - \frac{d^2 \bar{\mathbf{T}}}{dx^2} = \mathbf{0}$$

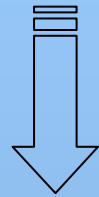
Matrix relative to transfer in the x direction

transverse conduction versus z

Semi-analytical extension for heterogeneous media

1. Diagonalization

$$\mathbf{M}_S(\mathbf{M}_{//} + \mathbf{G}_S) = \mathbf{P}\mathbf{\Omega}\mathbf{P}^{-1}$$



$$\mathbf{V} = \mathbf{P}^{-1}\bar{\mathbf{T}}$$

2. Resolution in the eigenvalues space

$$\mathbf{\Omega}\mathbf{V} - \frac{d^2\mathbf{V}}{dx^2} = \mathbf{0}$$

$$\mathbf{J}_V = -dz \frac{d\mathbf{V}}{dx}$$

$$\mathbf{A}_V = \mathbf{D}_V = \cosh(\sqrt{\mathbf{\Omega}}L)$$

$$\mathbf{B}_V = \sinh(\sqrt{\mathbf{\Omega}}L)(\sqrt{\mathbf{\Omega}}dz)^{-1}$$

$$\mathbf{C}_V = (dz\sqrt{\mathbf{\Omega}})\sinh(\sqrt{\mathbf{\Omega}}L)$$

3. Return to temperature / flux basis

$$\mathbf{A} = \mathbf{P}\mathbf{A}_V\mathbf{P}^{-1}$$

$$\mathbf{B} = \mathbf{P}\mathbf{B}_V(\mathbf{K}\mathbf{P})^{-1}$$

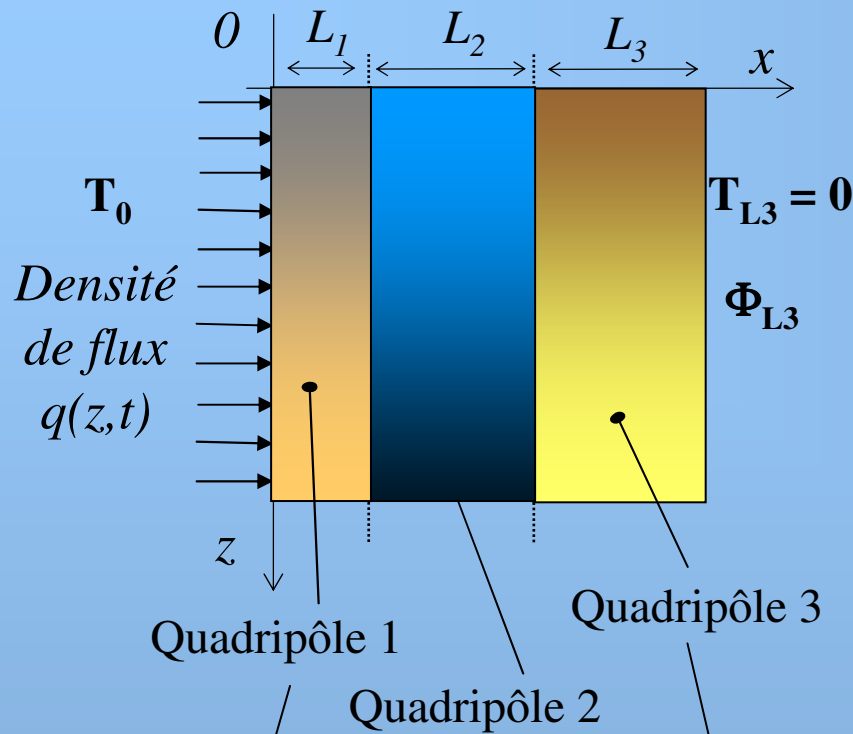
$$\mathbf{C} = \mathbf{K}\mathbf{P}\mathbf{C}_V\mathbf{P}^{-1}$$

$$\mathbf{D} = \mathbf{K}\mathbf{P}\mathbf{D}_V(\mathbf{K}\mathbf{P})^{-1}$$

$$\bar{\mathbf{\Phi}} = -dz\mathbf{K} \frac{d\bar{\mathbf{T}}}{dx} = \mathbf{K}\mathbf{P}\mathbf{J}_V$$

$$\begin{bmatrix} \bar{\mathbf{T}} \\ \bar{\mathbf{\Phi}} \end{bmatrix}_{x1} = \begin{bmatrix} \mathbf{A} & \mathbf{B} \\ \mathbf{C} & \mathbf{D} \end{bmatrix} \begin{bmatrix} \bar{\mathbf{T}} \\ \bar{\mathbf{\Phi}} \end{bmatrix}_{x2}$$

Implementation of the method



Direct computation with N points

(Numerical methods $\Rightarrow N^2$)

$$\begin{bmatrix} T_0 \\ \Phi_0 \end{bmatrix} = \begin{bmatrix} A_1 & B_1 \\ C_1 & D_1 \end{bmatrix} \begin{bmatrix} A_2 & B_2 \\ C_2 & D_2 \end{bmatrix} \begin{bmatrix} A_3 & B_3 \\ C_3 & D_3 \end{bmatrix} \begin{bmatrix} 0 \\ \Phi_{L3} \end{bmatrix}$$

**Wall temperature field
as a function
of the input heat flux**

**Macroscopic and local thermal characterization
from infrared images processing :
Analytical modeling and field estimation**

1. Introduction to infrared thermography
2. The Thermal Quadrupole Formalism
3. Field Estimation for Local Mapping
4. Macroscopic characterization from averaging
5. Conclusion

Linear least squares Maximum likelihood Estimator

$$T = X \beta$$

Hypothesis :

- zero mean and additive errors
- β constant and unknown before the estimation and X_{ij} known without error
- constant variance (σ known) and uncorrelated errors

$$S = (Y - X\hat{\beta})^t \cdot (Y - X\hat{\beta})$$

Estimator

$$\hat{\beta} = (X^t X)^{-1} X^t \hat{Y}$$

Estimation error

$$\text{cov}(e_{\beta}) = (X^t X)^{-1} \sigma^2$$

Example : Non-Stationary Signal -Estimation of one parameter

$$\begin{bmatrix} T_1 \\ T_2 \\ \vdots \\ \vdots \\ T_N \end{bmatrix} = \begin{bmatrix} f_1 \\ f_2 \\ \vdots \\ \vdots \\ f_N \end{bmatrix} \beta$$

$$\hat{\beta} = \frac{\sum_{i=1}^N f_i \hat{T}_i}{\sum_{i=1}^N f_i^2}$$

$$\sigma_{\beta}^2 = \frac{\sigma^2}{\sum_{i=1}^N f_i^2}$$

$$\|f(t)\| = \sqrt{\int_0^{t_{\max}} f^2(t) dt}$$

$$\sigma_{\beta}^2 = \frac{t_{\max} \sigma^2}{N \|f\|^2}$$

- If N small, T_i must be chosen as f is maximum
- T_i regularly spaced, N must be chosen as great as possible!

Estimation of several parameters

(f and g assumed to be orthogonal)

$$\begin{bmatrix} T_1 \\ T_2 \\ \vdots \\ T_N \end{bmatrix} = \underbrace{\begin{bmatrix} f_1 & g_1 \\ f_2 & g_2 \\ \vdots & \vdots \\ f_N & g_N \end{bmatrix}}_X \cdot \begin{bmatrix} \beta_1 \\ \beta_2 \end{bmatrix}$$

$$\hat{\beta}_1 = \frac{(f^t \cdot \hat{T})}{(f^t \cdot f)}$$

$$\hat{\beta}_2 = \frac{(g^t \cdot \hat{T})}{(g^t \cdot g)}$$

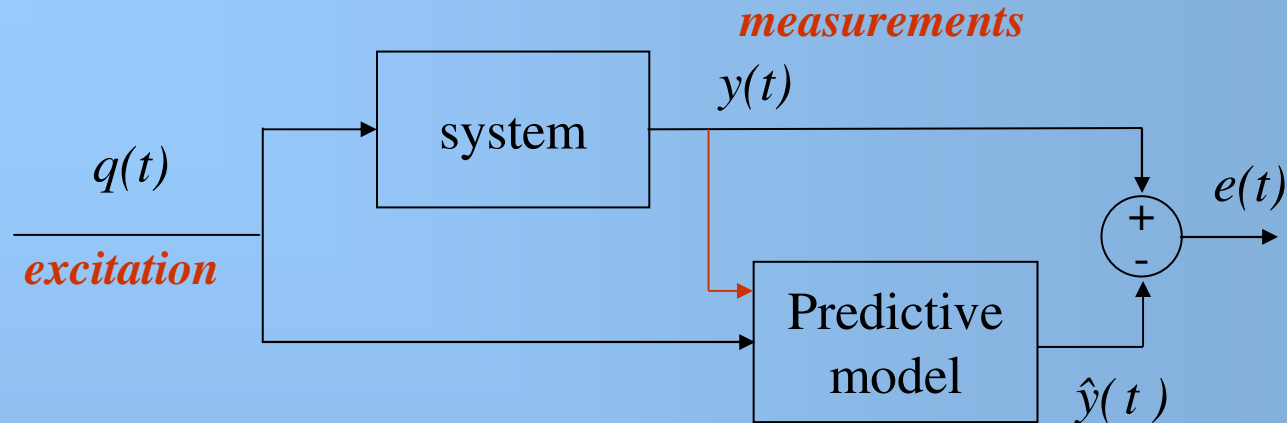
$$\text{cov}(\hat{\mathbf{B}}) = \sigma^2 \begin{pmatrix} (f^t f)^{-1} & 0 \\ 0 & (g^t g)^{-1} \end{pmatrix}$$

$$\text{cov}(\hat{\mathbf{B}}) \approx \sigma^2 \left(\frac{N}{t_{\max}} \right)^{-1} \begin{pmatrix} \|f\|^{-2} & 0 \\ 0 & \|g\|^{-2} \end{pmatrix}$$

$$\text{cond}(\text{cov}(\hat{\mathbf{B}})) \approx \frac{\|f\|^2}{\|g\|^2}$$

- T_i regularly spaced, N must be chosen as great as possible!
- The conditioning number is non-dependant on N !

Linear estimation : minimization of the prediction error $e(t)$



The regression matrix is filled with measurements

Sampled system

$$y(t_k) = \mathbf{H}(t_k)\beta + e(t_k)$$

$\hat{y}(t_k)$
 $\underbrace{\hspace{2cm}}$

n successive measurements

$$\mathbf{Y}_n = \mathbf{H}_n\beta + \mathbf{E}_n$$

OLS Estimation

$$\hat{\beta} = \left(\mathbf{H}_n^t \mathbf{H}_n\right)^{-1} \mathbf{H}_n^t \mathbf{Y}_n$$

Linear estimation : minimization of the prediction error $e(t)$

The cost = biased estimator

$$E(\hat{\boldsymbol{\beta}}) = \boldsymbol{\beta} + \left(E(\mathbf{H}_n^t \mathbf{H}_n) \right)^{-1} E(\mathbf{H}_n^t \mathbf{E}_n)$$

Bias is zero if :

$E(\mathbf{H}_n^t \mathbf{H}_n)$ non singular

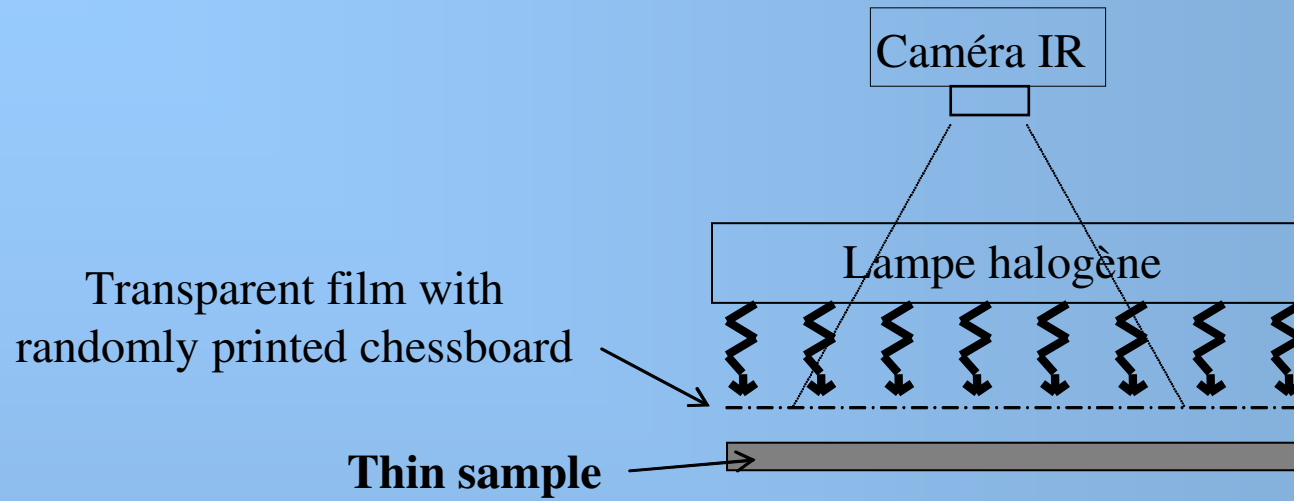
&

$e(t)$ is a white noise

or

The input $q(t)$ is independent of $e(t)$
and $H(t)$ does not depend of $y(t)$

Thermal diffusivity mapping from spatial random heating



$$\rho c(x, y) \frac{\partial T}{\partial t} = \frac{\partial}{\partial x} \left(k(x, y) \frac{\partial T}{\partial x} \right) + \frac{\partial}{\partial y} \left(k(x, y) \frac{\partial T}{\partial y} \right) - \frac{2h}{e} (T - T_{\infty})$$



Discretization

$$\mathbf{T}^{t+\Delta t} - \mathbf{T}^t = \mathbf{A} * \Delta \mathbf{T}^t + \mathbf{C}^{-1} * \delta_x \mathbf{K} * \delta_x \mathbf{T}^t + \mathbf{C}^{-1} * \delta_y \mathbf{K} * \delta_y \mathbf{T}^t - \mathbf{H} * (\mathbf{T}^t - T_{\infty})$$

Thermal diffusivity mapping from spatial random heating

$$\hat{\mathbf{T}}' - \hat{\mathbf{T}} = \begin{bmatrix} \hat{\mathbf{T}}^{t_0 + \Delta t} - \hat{\mathbf{T}}^{t_0} \\ \cdot \\ \hat{\mathbf{T}}^{t + \Delta t} - \hat{\mathbf{T}}^t \\ \cdot \end{bmatrix} \quad \mathbf{X} = \begin{bmatrix} \Delta \hat{\mathbf{T}}^{t_0} & \delta_x \hat{\mathbf{T}}^{t_0} & \delta_y \hat{\mathbf{T}}^{t_0} & \hat{\mathbf{T}}^{t_0} - T_\infty \\ \cdot & \cdot & \cdot & \cdot \\ \Delta \hat{\mathbf{T}}^t & \delta_x \hat{\mathbf{T}}^t & \delta_y \hat{\mathbf{T}}^t & \hat{\mathbf{T}}^t - T_\infty \\ \cdot & \cdot & \cdot & \cdot \end{bmatrix}$$

$$\hat{\boldsymbol{\beta}} = (\mathbf{X}^t \mathbf{X})^{-1} \mathbf{X}^t (\hat{\mathbf{T}}' - \hat{\mathbf{T}})$$

Point by point estimation

$\mathbf{X}^t \mathbf{X} = 4 \times 4$ matrix

Sequential implementation of the sums
(Recursive estimation)

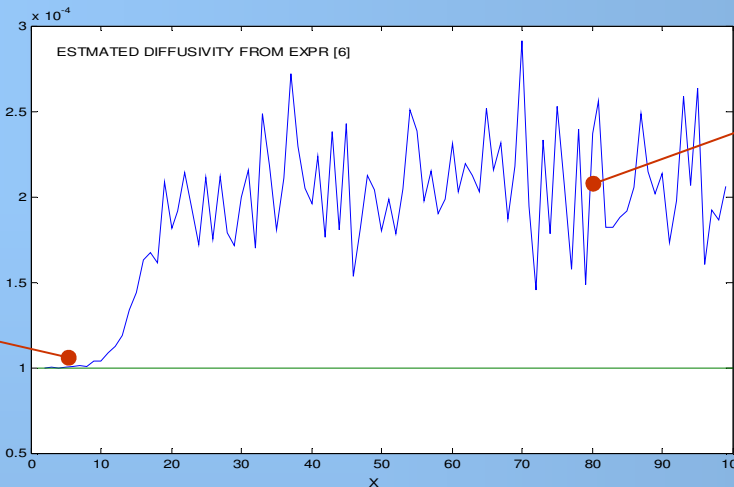
$$\beta_{ij} = \begin{bmatrix} a_{ij} \\ \frac{\delta_x k_{ij}}{(\rho c)_{ij}} \\ \frac{\delta_y k_{ij}}{(\rho c)_{ij}} \\ H_{ij} \end{bmatrix}$$

Simplified model

$$\hat{\boldsymbol{\beta}} \equiv \mathbf{A} \implies \hat{A} = \frac{\sum_{i=0}^n \Delta \hat{\mathbf{T}}^{t_i} \cdot (\hat{\mathbf{T}}^{t_i + \Delta t} - \hat{\mathbf{T}}^{t_i})}{\sum_{i=0}^n (\Delta \hat{\mathbf{T}}^{t_i})^2}$$

Thermal diffusivity mapping from spatial random heating

Correct estimation
in the
perturbed region



Important bias
in the
unperturbed region

Homogeneous plate with local heating

Periodic heating

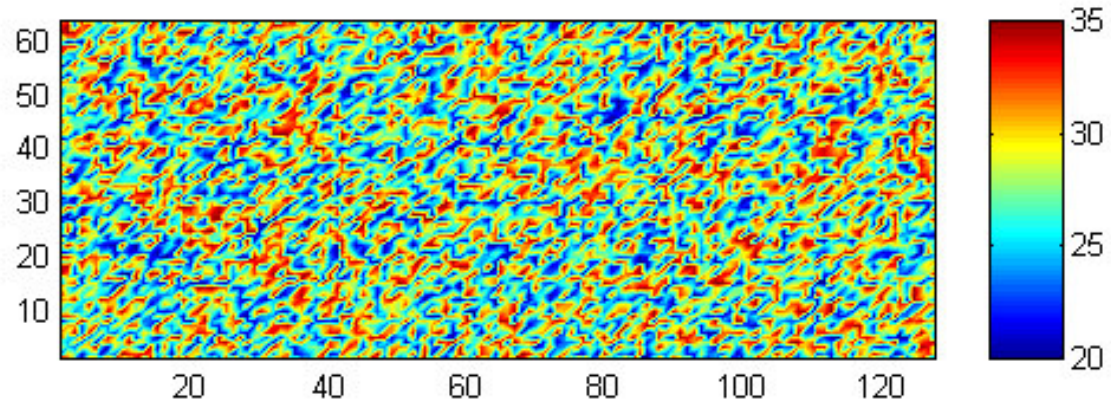


Periodic bias in the
unperturbed points

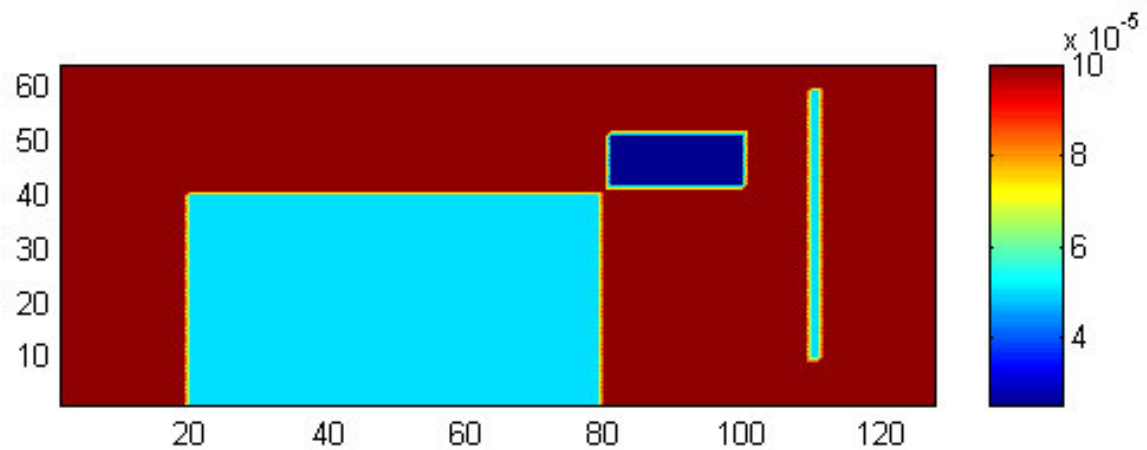
$$\hat{A} = \frac{\sum_{i=0}^n \Delta \hat{T}^{t_i} \cdot (\hat{T}^{t_i + \Delta t} - \hat{T}^{t_i})}{\sum_{i=0}^n (\Delta \hat{T}^{t_i})^2}$$

Thermal diffusivity mapping from spatial random heating

**Initial
randomly distributed
temperature field**

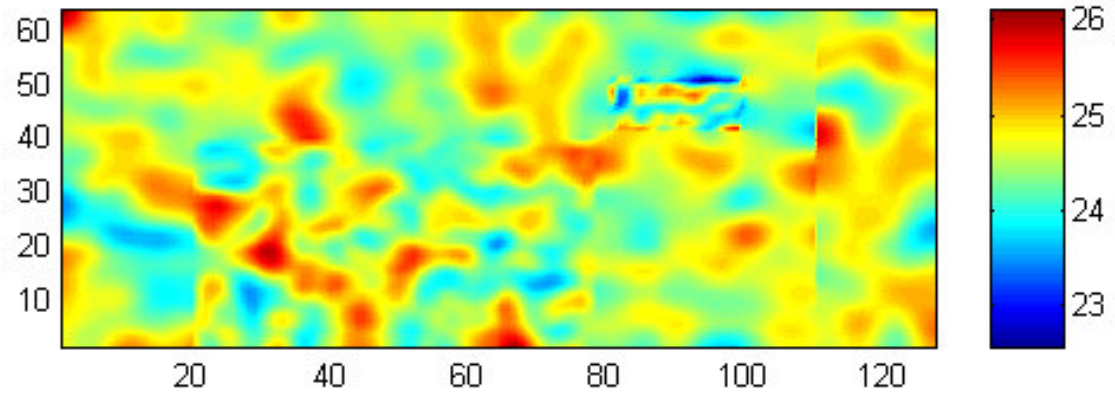


Sample

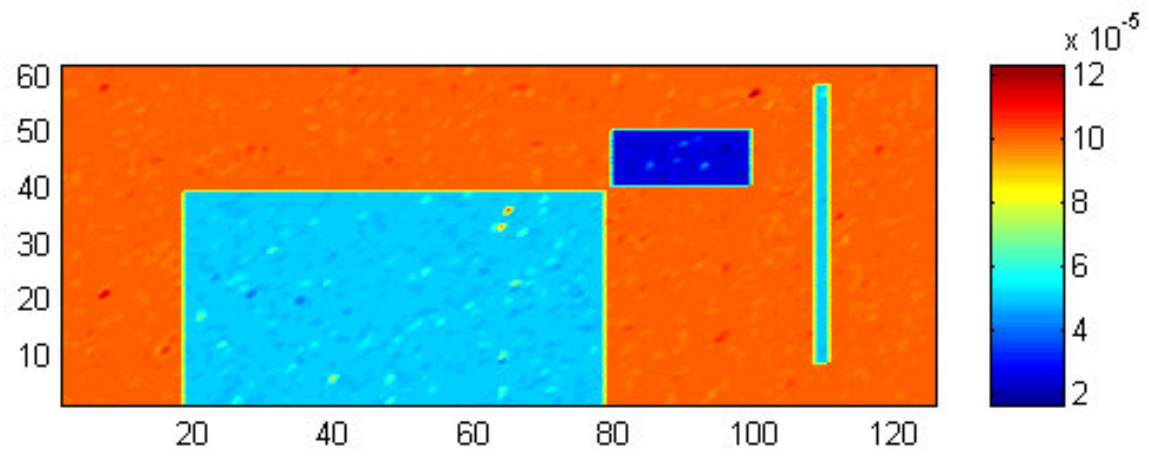


Thermal diffusivity mapping from spatial random heating

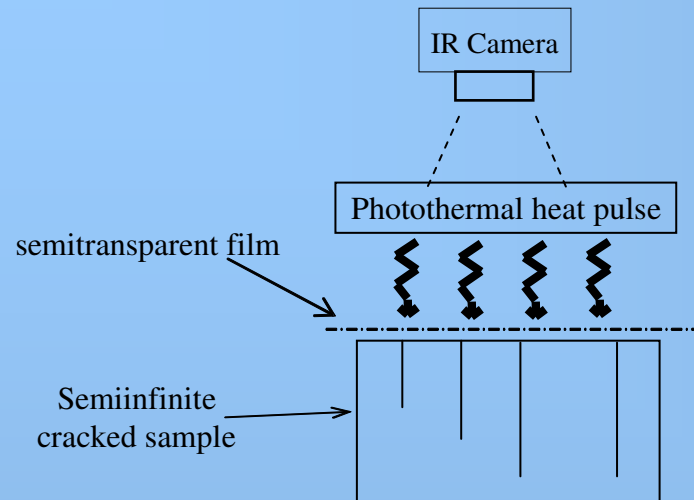
**Final
temperature field**



**Estimated
thermal diffusivity
field**



Thermal diffusivity mapping from spatial random heating



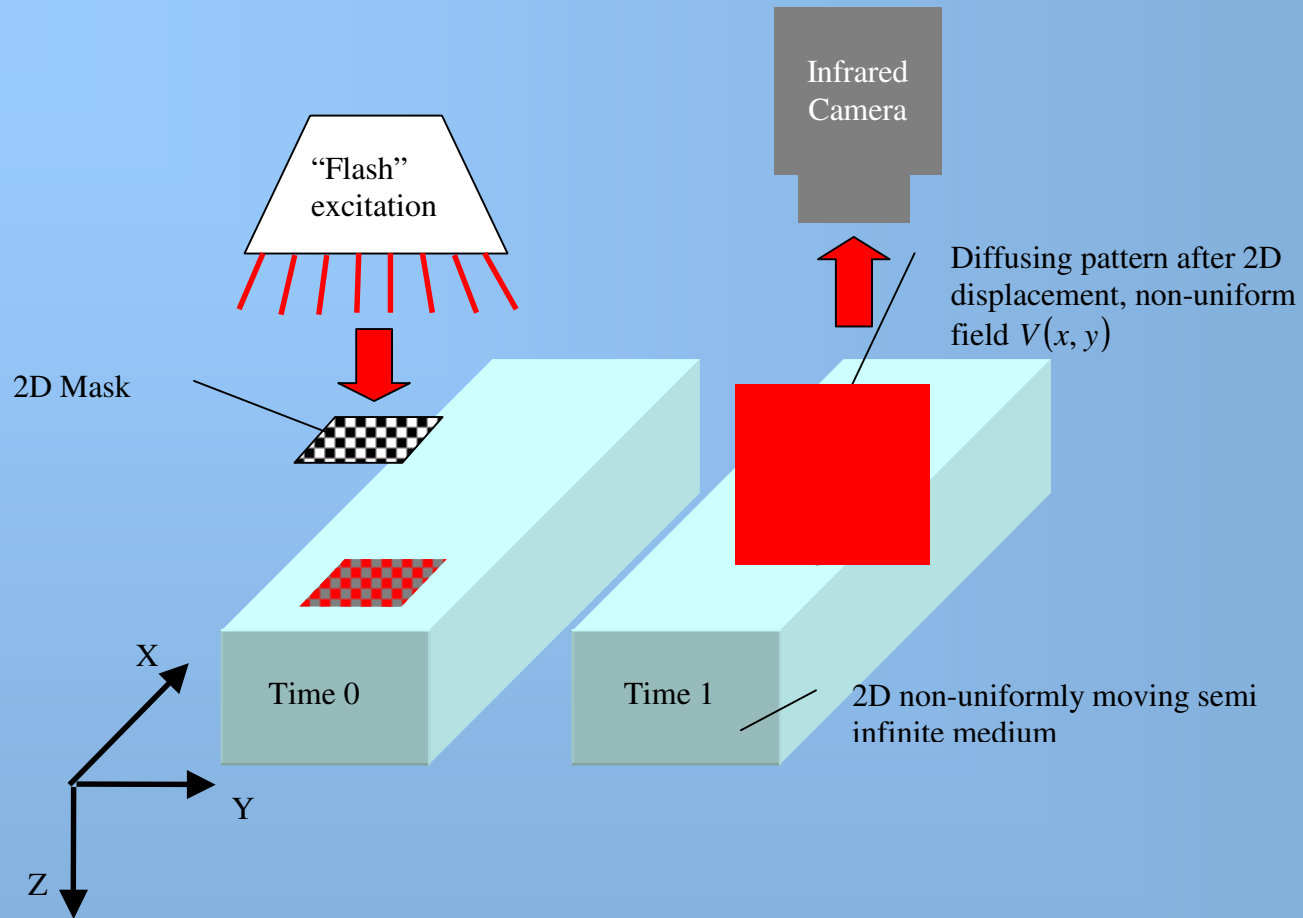
**Thick Sample
(semi-infinite)**

$$T(x, y, z, t) = T_{x,y}(x, y, t) \cdot T_z(z, t) \quad \text{Separability}$$

$$T_{x,y}(x, y, t) = T(x, y, z = 0, t) \cdot \sqrt{t} \quad \text{New Observable variable}$$

$$\hat{\beta}_{ML} = \left(\hat{\mathbf{X}}' \mathbf{t}^{-1} \hat{\mathbf{X}} \right)^{-1} \hat{\mathbf{X}}' \mathbf{t}^{-1} \left(\hat{\mathbf{Y}}^{\mathbf{t}+\Delta\mathbf{t}} - \hat{\mathbf{Y}}^{\mathbf{t}} \right)$$

Velocity and diffusion mapping for a moving solid



$$\frac{\partial I(x, y, z, t)}{\partial t} + V_x \frac{\partial I(x, y, z, t)}{\partial x} + V_y \frac{\partial I(x, y, z, t)}{\partial y} = a \cdot \left(\frac{\partial^2 T(x, y, z, t)}{\partial x^2} + \frac{\partial^2 T(x, y, z, t)}{\partial y^2} + \frac{\partial^2 T(x, y, z, t)}{\partial z^2} \right)$$

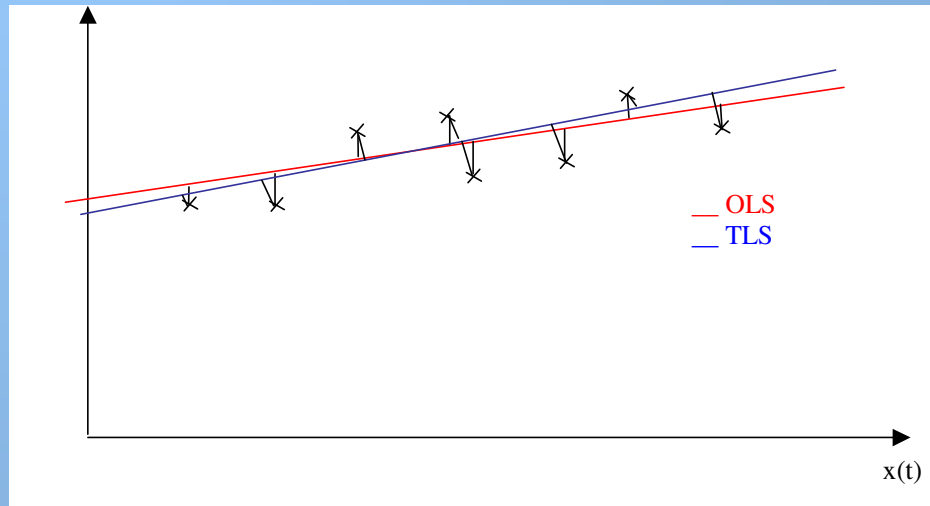
Total Least Square Estimation

$$\frac{\partial T_{x,y}(x,y,t)}{\partial t} + V_x \frac{\partial T_{x,y}(x,y,t)}{\partial x} + V_y \frac{\partial T_{x,y}(x,y,t)}{\partial y} = a \cdot \left(\frac{\partial^2 T_{x,y}(x,y,t)}{\partial x^2} + \frac{\partial^2 T_{x,y}(x,y,t)}{\partial y^2} \right)$$

$$X\beta = Y \quad \Rightarrow \quad [X \quad -1] \begin{bmatrix} \beta \\ Y \end{bmatrix} = \mathbf{0}$$

$$D(x, y) (x, y) = 0$$

$$\left\{ \begin{array}{l} (x, y) = \begin{bmatrix} \vdots & \vdots & \vdots & \vdots \\ \frac{\partial T}{\partial x}(x, y, t_i) & \frac{\partial T}{\partial y}(x, y, t_i) & -\left(\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2}\right)(x, y, t) & \frac{\partial T}{\partial t}(x, y, t_i) \\ \vdots & \vdots & \vdots & \vdots \end{bmatrix} \\ (x, y) = \begin{bmatrix} V_x(x, y) & V_y(x, y) & a(x, y) & 1 \end{bmatrix}^T \end{array} \right.$$



Total Least Square Estimation

$$\left\{ (x, y), \left\| \begin{pmatrix} x \\ y \end{pmatrix} - \begin{pmatrix} x \\ y \end{pmatrix} \right\|^2 = \min \right\}$$

With the constraint $\left\| \begin{pmatrix} x \\ y \end{pmatrix} \right\|^2 = 1$

$$\left\{ (x, y), \left\| \begin{pmatrix} x \\ y \end{pmatrix} - \begin{pmatrix} x \\ y \end{pmatrix} \right\|^2 + \lambda \left(1 - \left\| \begin{pmatrix} x \\ y \end{pmatrix} \right\|^2 \right) = \min \right\}$$

Lagrange multipliers

$$\begin{pmatrix} x \\ y \end{pmatrix} = \begin{pmatrix} x \\ y \end{pmatrix}^T \begin{pmatrix} x \\ y \end{pmatrix}$$

Total Least Square Estimation

Minimum for (x, y) $(x, y) = \lambda(x, y)$ (x, y)

$$V_{min}(x, y) \quad \lambda_{min}(x, y)$$

Eigenvector associated with the minimum eigenvalue

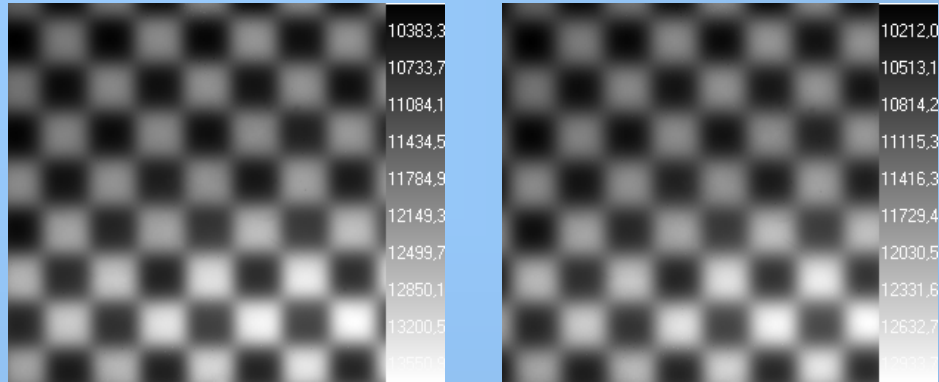
BUT $\lambda_N \geq \lambda_{N-1} \geq \dots > \lambda_p \approx \dots \approx \lambda_0 \approx 0$

Threshold ?

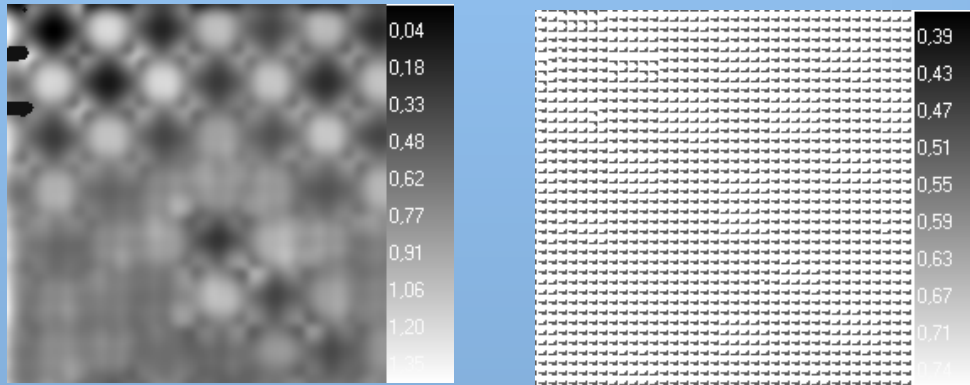
Noise subspace dimension ?

- spanned by the eigenvectors of the “close to zero” eigenvalues -

Velocity and diffusion mapping for a moving solid

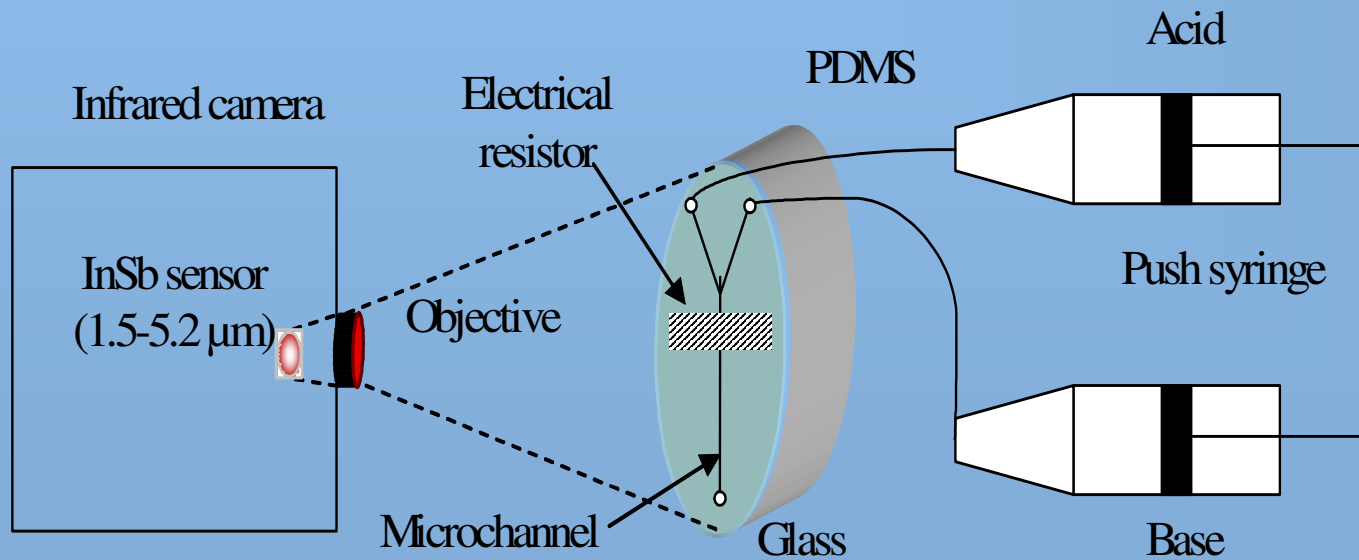
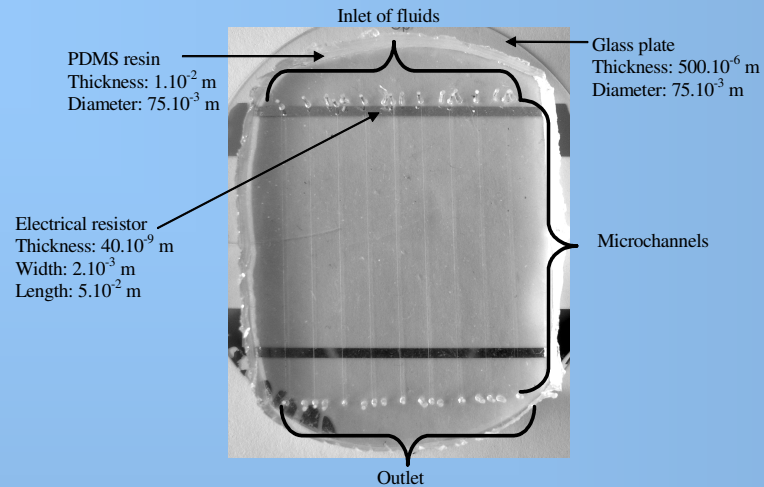


Infrared sequence showing a moving and diffusing pattern

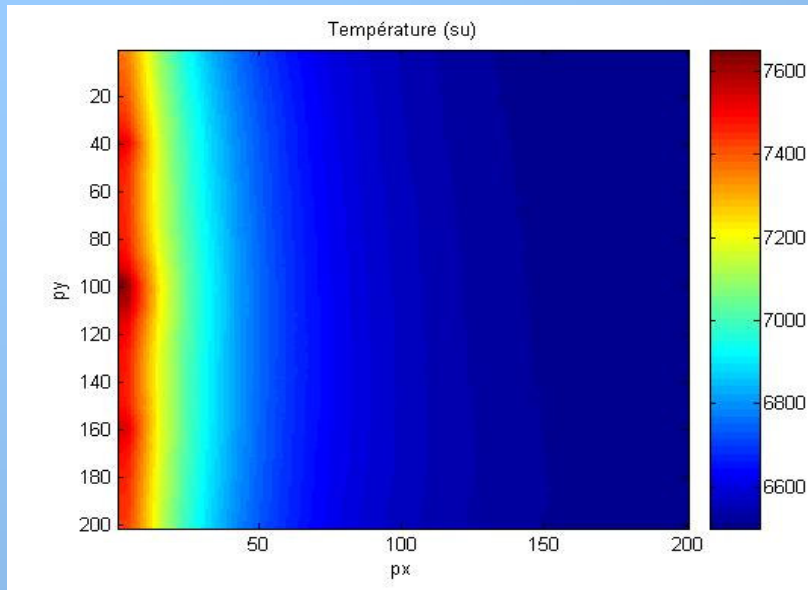


Diffusivity and velocity mapping from previous image sequence sampled at 25 Hz

Processing of temperature fields in microfluidic chips

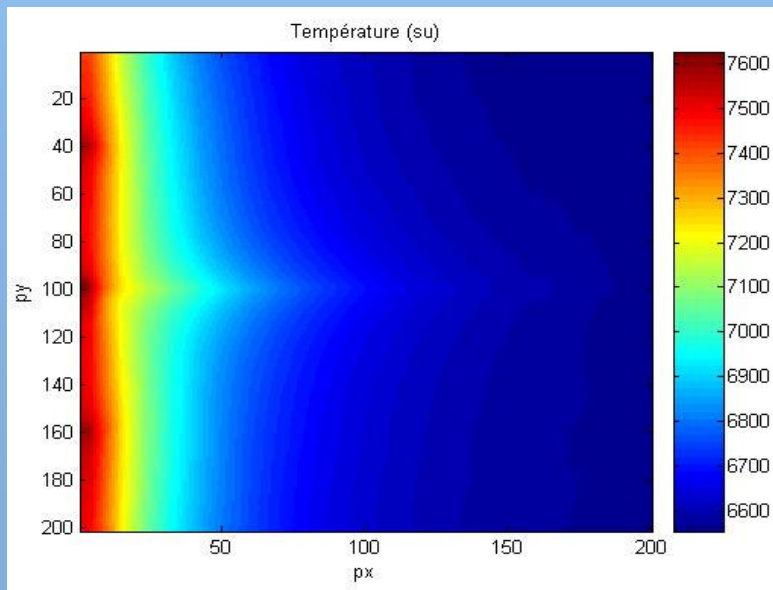


Temperature fields



Without flow

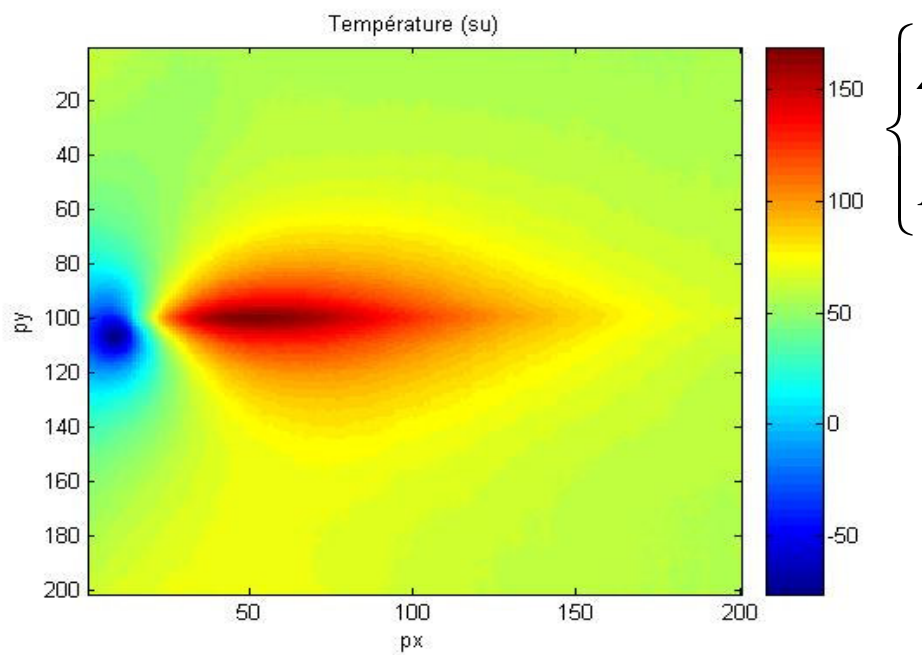
$$\frac{\partial^2 T^0}{\partial x^2} + \frac{\partial^2 T^0}{\partial y^2} - H(x, y)T^0 + \phi(x, y) = 0$$



With flow

$$\frac{V(x, y)}{a} \frac{\partial T}{\partial x} = \left(\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} \right) + \phi(x, y)$$

Temperature difference between initial and perturbed field



$$\begin{cases} \Delta(T_{i,j}^0) + \phi_{i,j} = 0 \\ Pe_{i,j} \delta(T_{i,j}) = \Delta(T_{i,j}) + \phi_{i,j} = \Delta(T_{i,j} - T_{i,j}^0) \end{cases}$$

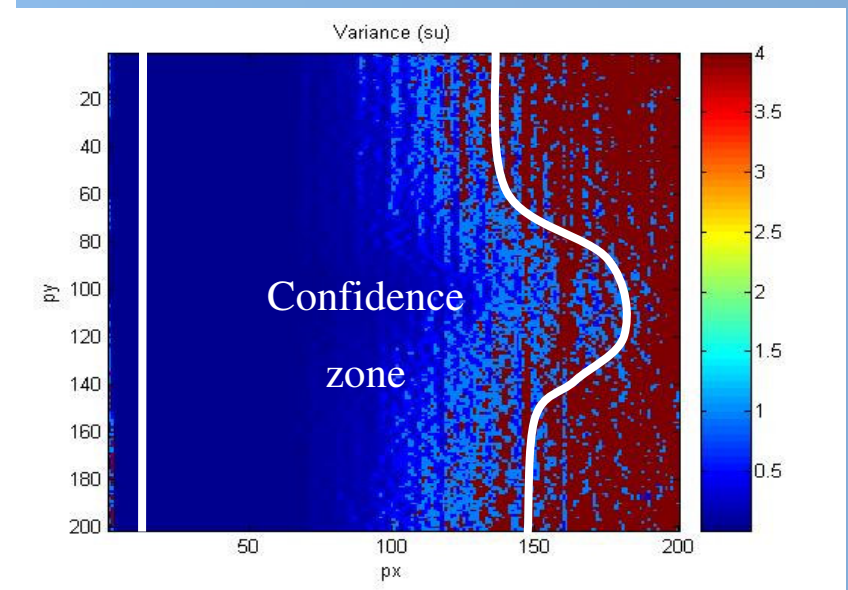
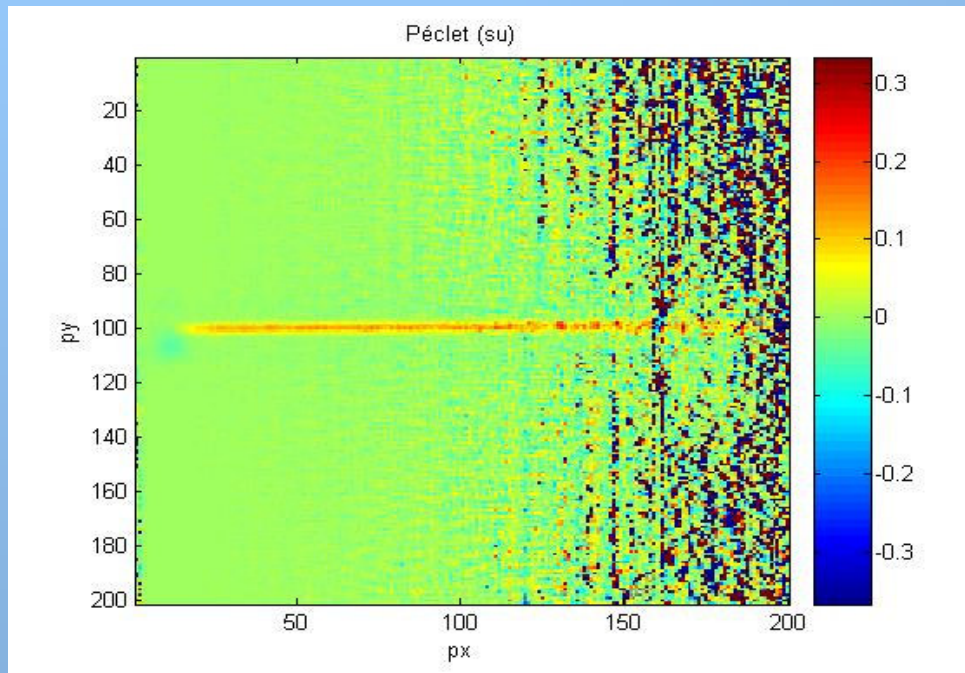
$$Pe_{i,j} = \frac{\Delta(T_{i,j} - T_{i,j}^0)}{\delta(T_{i,j})}$$

Fictitious temperature field :

$$\delta(T_{i,j} - T_{i,j}^0) Pe_{i,j} = \Delta(T_{i,j} - T_{i,j}^0) - \delta(T_{i,j}^0) Pe_{i,j}$$

↑
Artificial source term

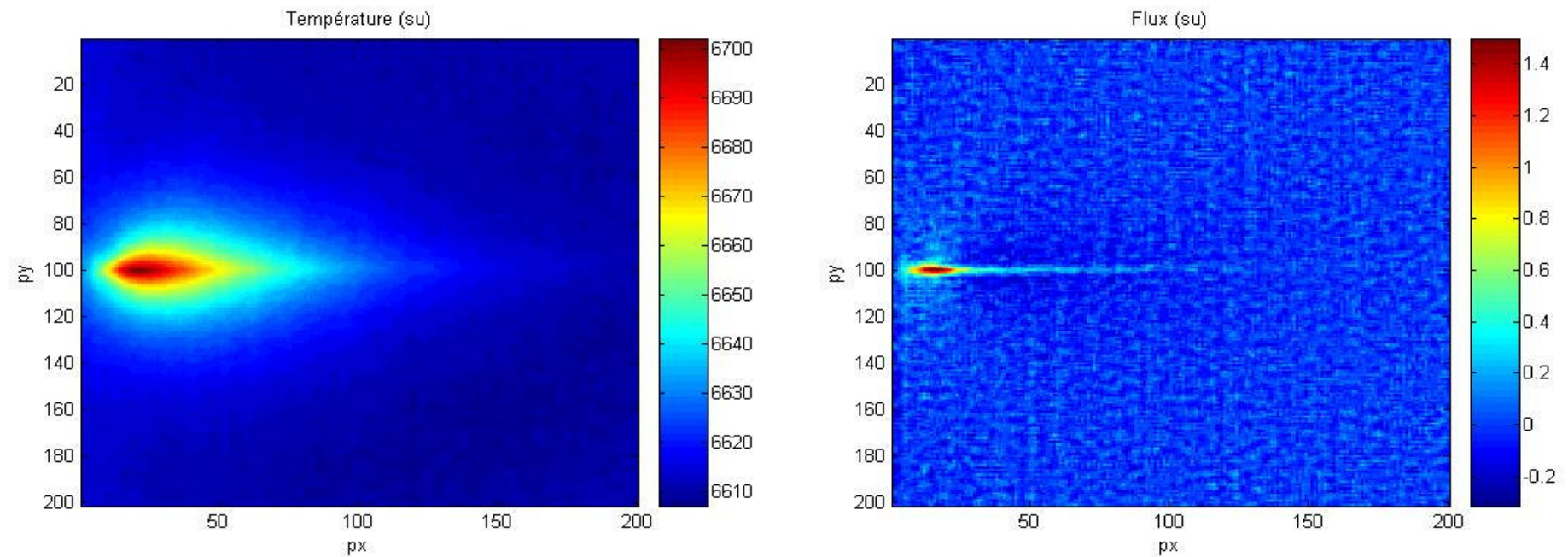
Peclet field $Pe_{i,j}$ estimation



$$Pe_{i,j} = \frac{\Delta(T_{i,j} - T_{i,j}^0)}{\delta(T_{i,j})}$$

$$\text{var}(Pe_{i,j}) = 40 \sigma^2 \delta T_{i,j}^{-2}$$

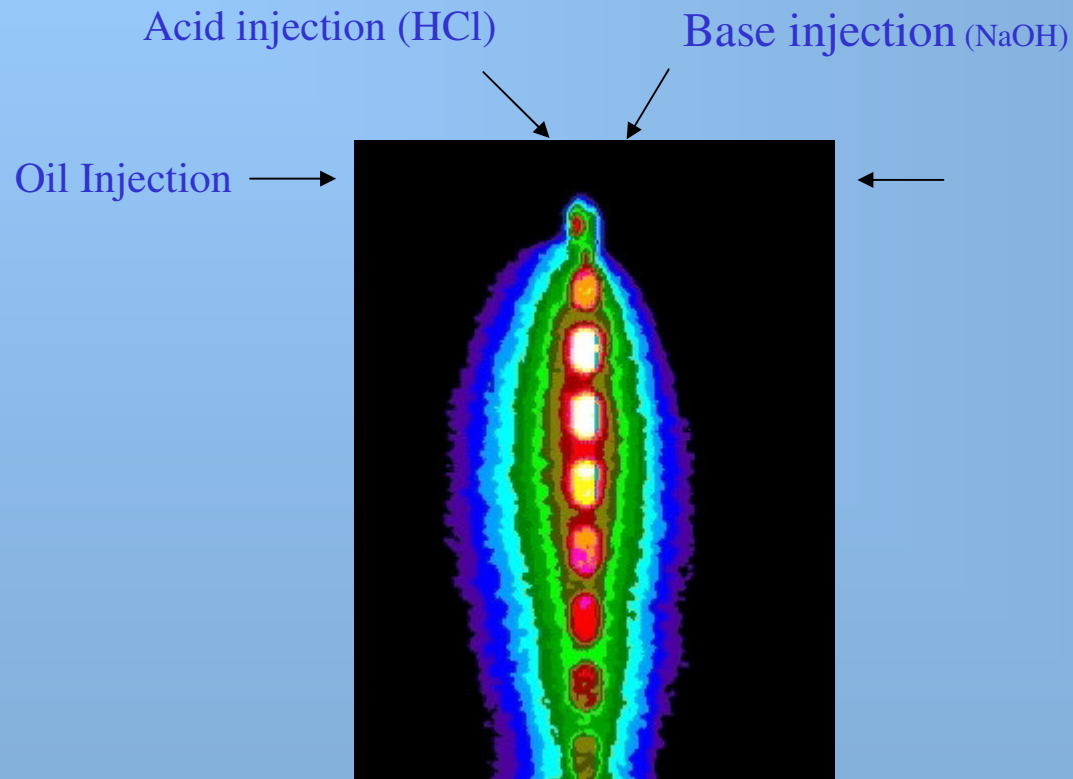
Application to a chemical reaction characterization



Temperature field T^c , at $Q = 1000 \mu\text{lh}$

Chemical source term at $Q = 1000 \mu\text{lh}$

-Reactive Droplets

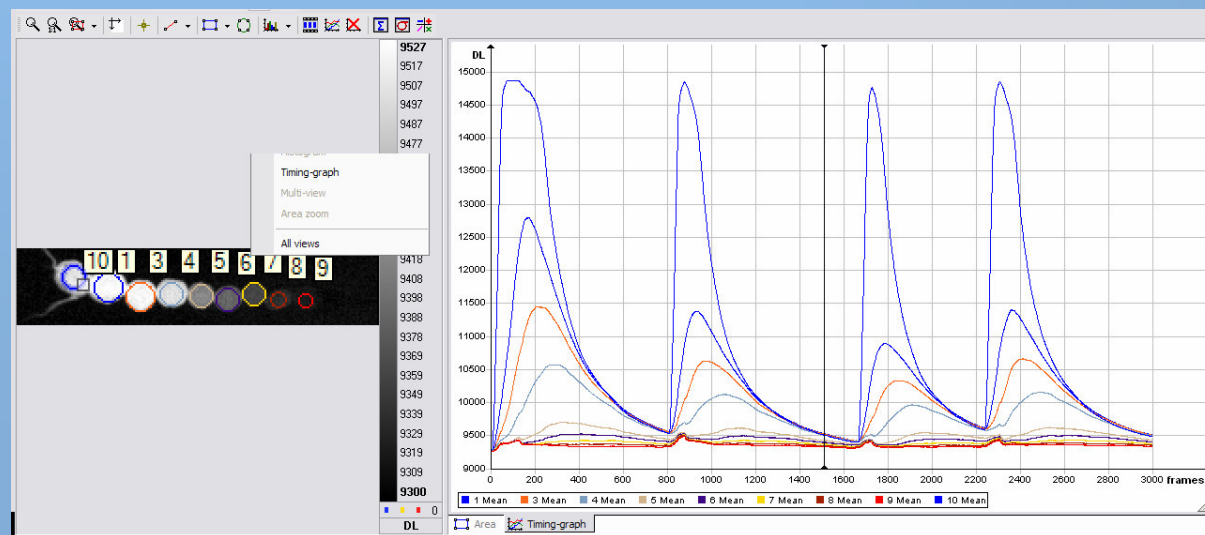
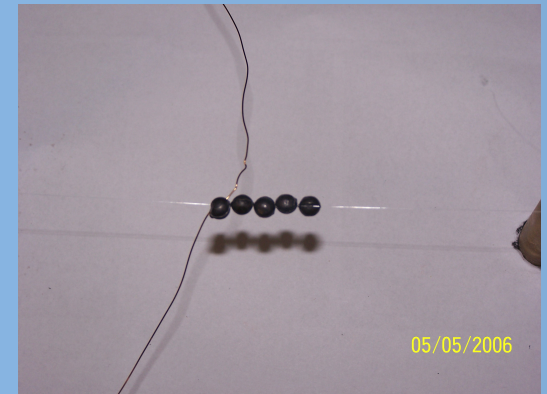
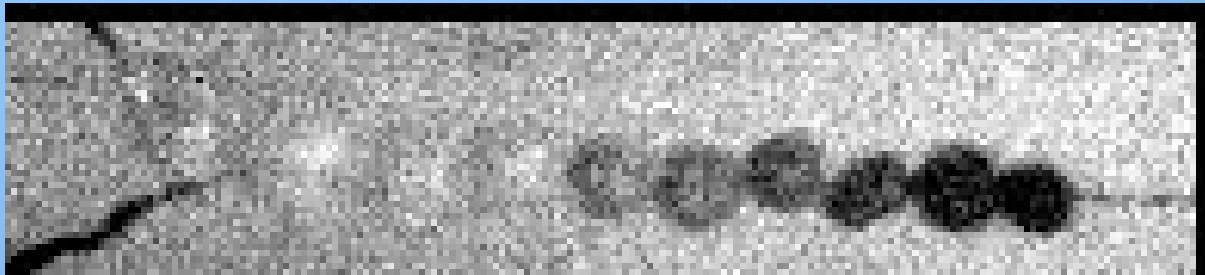


Quasi instantaneous mixing
1 droplet = 1 microreactor
Intensification of the experiments!

-Granular or dispersed media

Lead grains of 1mm of diameter (reduction of the ratio volume/contact surface)

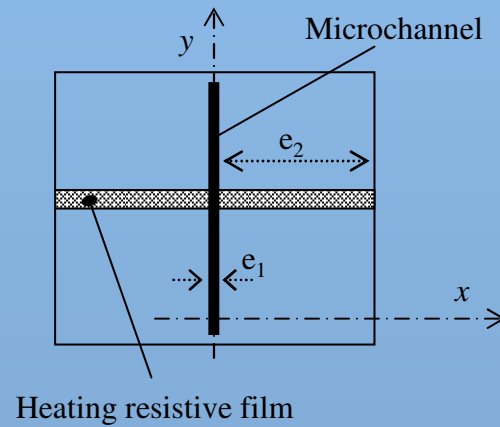
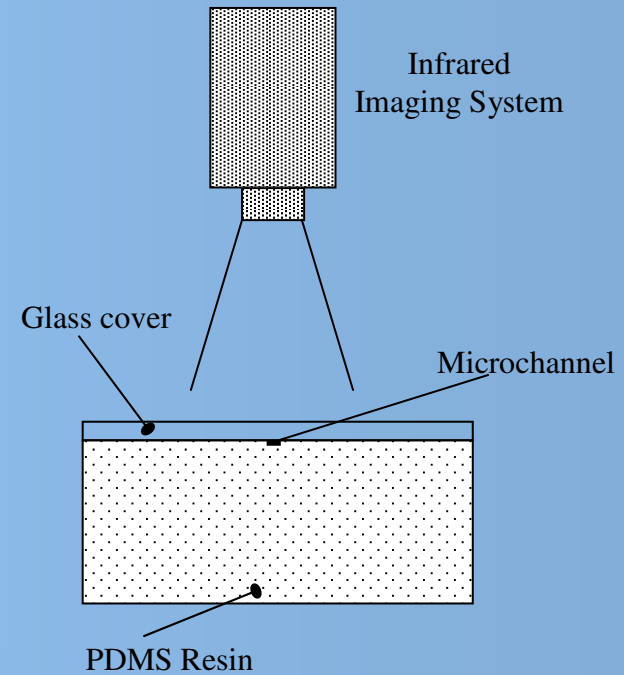
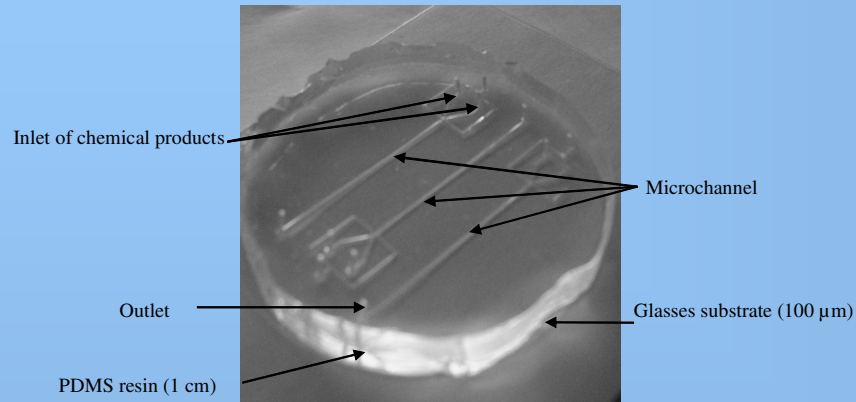
Applications to thermomechanics



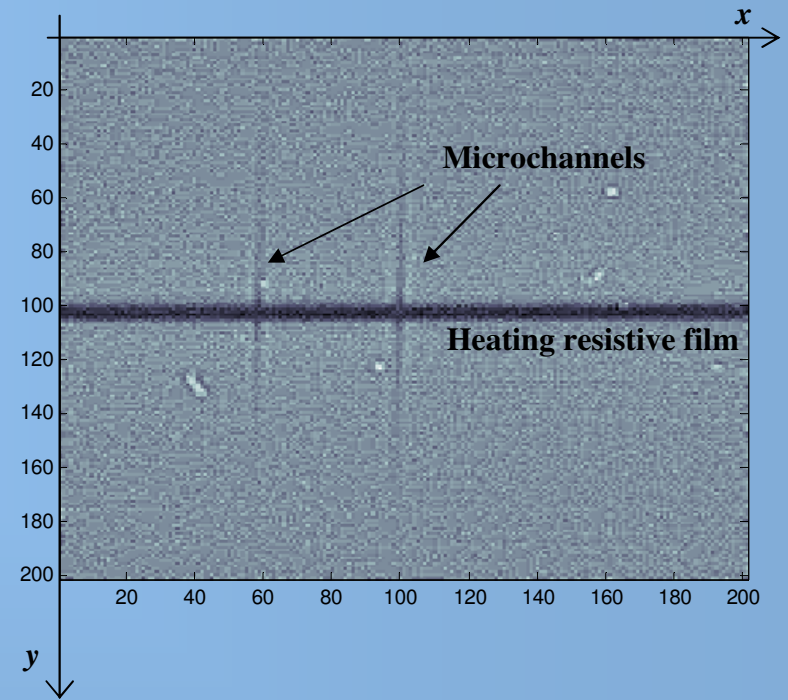
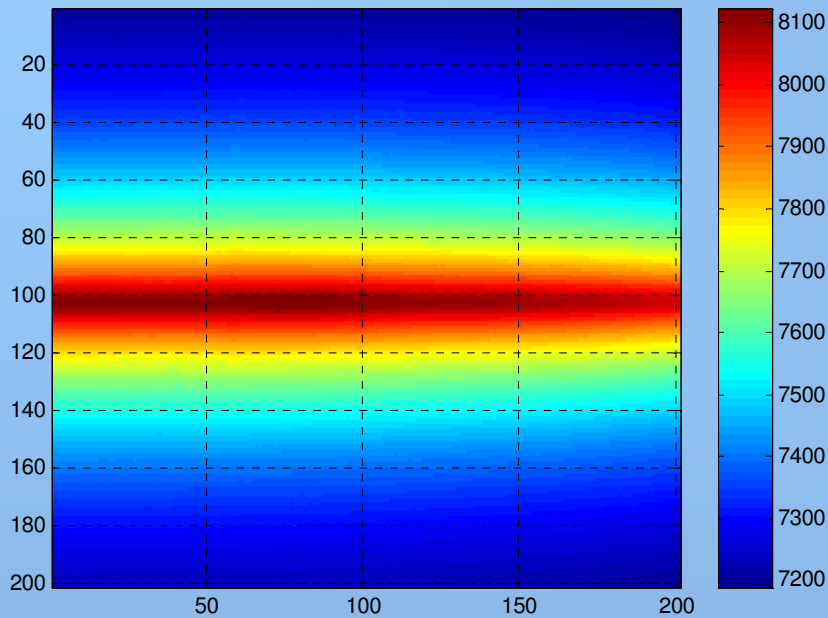
**Macroscopic and local thermal characterization
from infrared images processing :
Analytical modeling and field estimation**

1. Introduction to infrared thermography
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4. Macroscopic characterization from averaging
5. Conclusion

Macroscopic characterization from averaging



Macroscopic characterization from averaging



$$\frac{\partial}{\partial x} \left(k \frac{\partial Y}{\partial x} \right) + \frac{\partial}{\partial y} \left(k \frac{\partial Y}{\partial y} \right) + \frac{g}{k} - HY = 0$$

$$\Delta Y = - \frac{\partial k}{\partial x} \frac{\partial Y}{\partial x} - \frac{\partial k}{\partial y} \frac{\partial Y}{\partial y} - \frac{g}{k} + HY$$

Macroscopic characterization from averaging

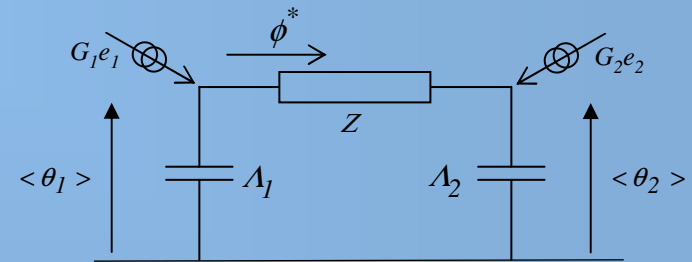
$$\frac{\partial^2 T_i}{\partial x^2} + \frac{\partial^2 T_i}{\partial y^2} + \frac{g_i(y,t)}{k_i} = \frac{1}{a_i} \frac{\partial T_i}{\partial t} + \frac{v_i}{a_i} \frac{\partial T_i}{\partial y}$$

Two Temperature Model :

$$k_1 \beta_1^2 e_1 \langle \theta_1 \rangle = G_1 e_1 - \phi^*$$

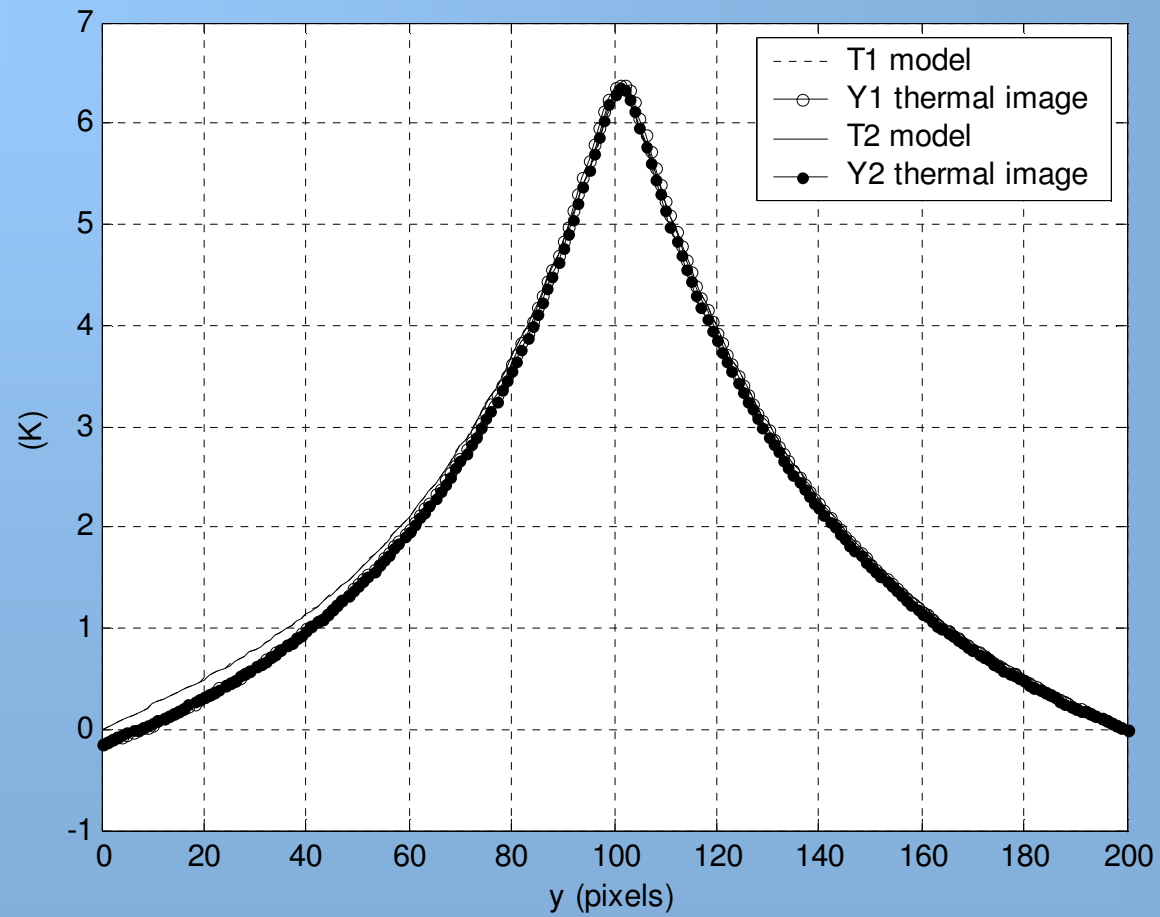
$$k_2 \beta_2^2 e_2 \langle \theta_2 \rangle = G_2 e_2 + \phi^*$$

$$\langle \theta_1 \rangle - \langle \theta_2 \rangle = Z \phi^*$$

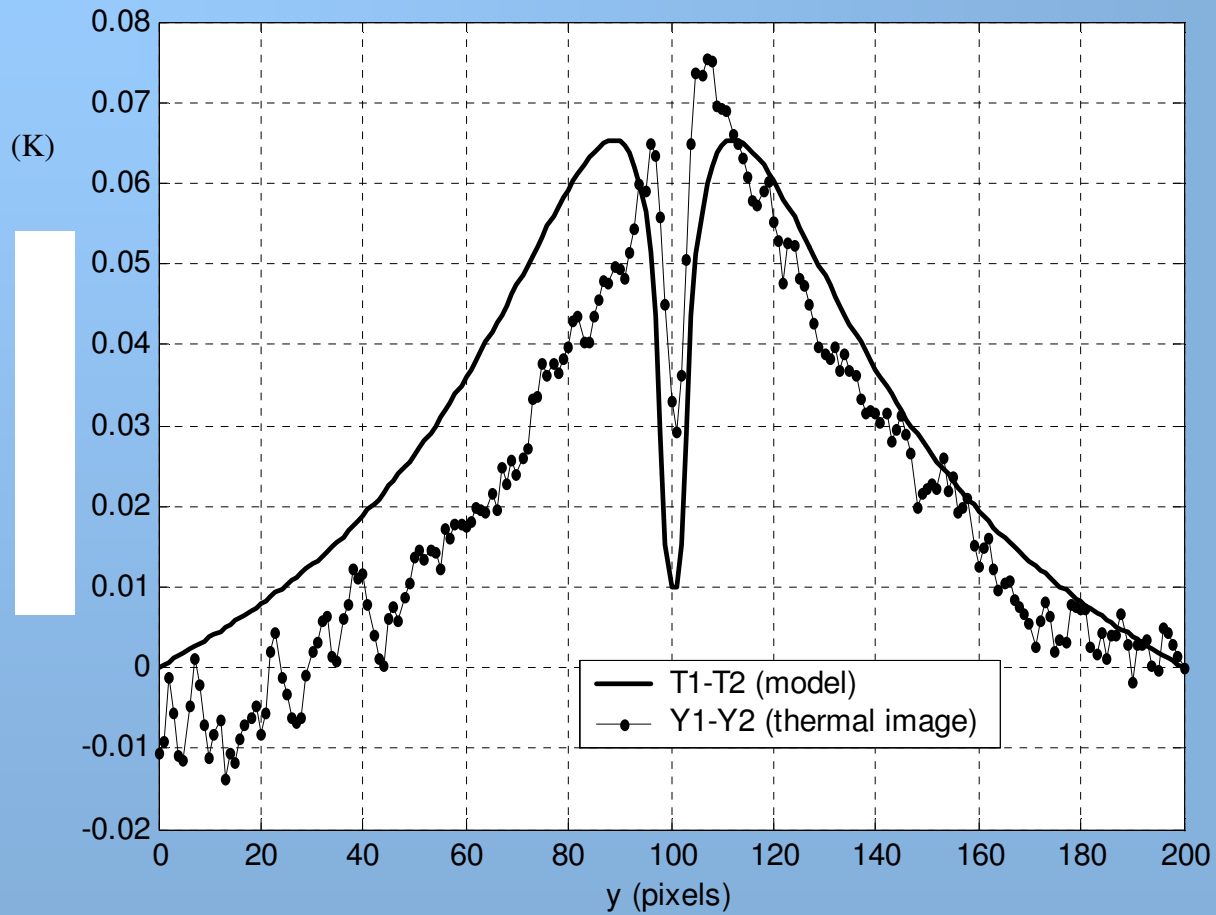


Macroscopic characterization from averaging

Fitted with
Heat losses
H

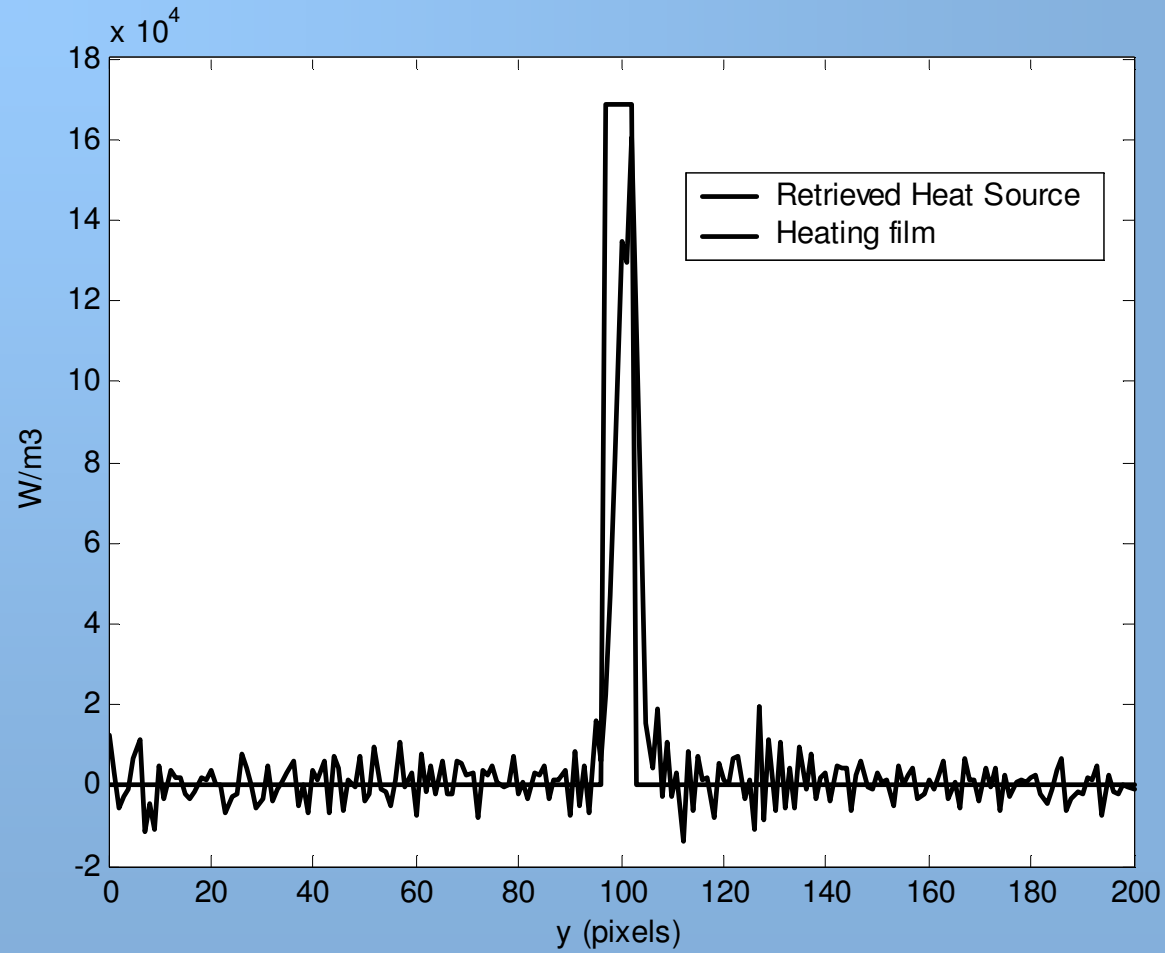


Macroscopic characterization from averaging



Average Temperature Difference

Macroscopic characterization from averaging



Retrieved Heat Source

Conclusion and perspectives

Biodiagnostic : Stress Thermal Signature Analysis

Microwire thermal conductivity

Time and space correlation analysis

SVD analysis

GITT

A new ill-posed problem...

Chile = Pisco sour

Brasil = Caipirinhia

Francia = Kir royal !

Argentina = ???

